

24-Bit, 2 MSPS, Dual Channel, Precision Differential SAR ADC

FEATURES

- ▶ High performance
 - ▶ Throughput: 2 MSPS per channel maximum
 - ▶ INL: ±0.9 ppm maximum from -40°C to +125°C
 - ▶ SNR: 105.7 dB typical, THD: -127 dB typical
 - ▶ NSD: -166 dBFS/Hz typical
- ▶ Low power
 - ▶ 15 mW per channel at 2 MSPS
 - ▶ 1.5 mW per channel at 10 kSPS
- ▶ Easy Drive features reduce system complexity
 - Very low 0.6 μA input current for dc inputs
 - Wide input common-mode range: −(1/128) × V_{REF} to +(129/128) × V_{REF}
- ▶ Flexible external reference voltage range: 4.096 V to 5 V
 - Accurate integrated reference buffer with 2 μF bypass capacitor
- ▶ Programmable block averaging filter with up to 2¹⁶ decimation
 - Extended sample resolution to 30 bits,
 - Over range and synchronization bits
- ► Flexi-SPI digital interface
 - ▶ 1, 2, or 4 SDO lanes/channel allows slower SCK
 - ▶ Echo clock mode simplifies use of digital isolator
 - ► Compatible with 1.2 V to 1.8 V logic
- ▶ 7 mm × 7 mm 64-Ball CSP_BGA package with internal supply and reference capacitors to help reduce system footprint

APPLICATIONS

- Automatic test equipment
- Digital control loops
- Medical instrumentation
- Seismology
- Semiconductor manufacturing
- Scientific instrumentation

FUNCTIONAL BLOCK DIAGRAM

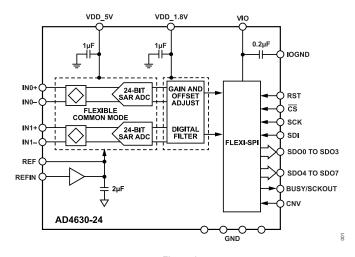


Figure 1.

GENERAL DESCRIPTION

The AD4630-24 is a two-channel, simultaneous sampling, Easy Drive, 2 MSPS successive approximation register (SAR) analog-to-digital converter (ADC). With a guaranteed maximum ±0.9 ppm INL and no missing codes at 24-bits, the AD4630-24 achieves unparalleled precision from -40°C to +125°C. Figure 1 shows the functional architecture of the AD4630-24.

A low-drift, internal precision reference buffer eases voltage reference sharing with other system circuitry. The AD4630-24 offers a typical dynamic range of 106 dB when using a 5 V reference. The low noise floor enables signal chains requiring less gain and lower power. A block averaging filter with programmable decimation ratio can increase dynamic range up to 153 dB. The wide differential input and common mode ranges allow inputs to use the full $\pm V_{REF}$ range without saturating, simplifying signal conditioning requirements and system calibration. The improved settling of the Easy Drive analog inputs broadens the selection of analog front-end components compatible with the AD4630-24. Both single-ended and differential signals are supported.

The versatile Flexi-SPI serial interface eases host processor and ADC integration. A wide data clocking window, multiple SDO lanes, and optional DDR data clocking can reduce the serial clock to 10 MHz while operating at a sample rate of 2 MSPS. Echo clock mode and ADC master clock mode relax the timing requirements and simplify the use of digital isolators.

The AD4630-24's BGA package integrates all critical power supply and reference bypass capacitors, reducing the footprint and system component count, and lessening sensitivity to board layout.

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 $VDD_5V = 5.4 \text{ V}$, $VDD_1.8V = 1.8 \text{ V}$, VIO = 1.8V, REFIN = 5 V, input common mode = 2.5 V, $f_S = 2$ MSPS, and all specifications T_{MIN} to T_{MAX} , unless otherwise noted. Typical values are at $T_A = 25^{\circ}C$.

Table 1.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
RESOLUTION		24			Bits
ANALOG INPUT					
Voltage Range	V _{IN+} - V _{IN-}	-(65/64) × V _{REF}		+(65/64) × V _{REF}	V
Absolute Input Voltage	V _{IN+} , V _{IN-} to GND	-(1/128) × V _{REF}		+(129/128) × V _{REF}	V
Common-Mode Input Range	$(V_{IN+} + V_{IN-})/2$	-(1/128) × V _{REF}		+(129/128) × V _{REF}	V
Common-Mode Rejection Ratio (CMRR)	f _{IN} = 10 kHz	, , ,,	132	, , ,	dB
Analog Input Current	Acquisition phase, T = 25°C		0.4		nA
	Converting any dc input at 2 MSPS		0.6		μA
Analog Input Capacitance	Acquisition phase		60		pF
	Outside acquisition phase (C _{PIN})		2		pF
THROUGHPUT					
Complete Cycle		500			ns
Conversion Time		264	282	300	ns
Acquisition Phase ¹		244	260	275	ns
Throughput Rate		0		2	MSPS
DC ACCURACY					
No Missing Codes		24			Bits
Integral Nonlinearity Error (INL)		-0.9	±0.1	0.9	ppm
Differential Nonlinearity Error (DNL)			±0.5		LSB
Transition Noise			29.7		LSB rms
Zero Error		-90	0	+90	μV
Zero Error Drift			±0.007		ppm/°C
Gain Error	Buffer disabled, REF = 5 V	-0.004	±0.0002	+0.004	%FS
Call Little	Buffer enabled, REFIN = 5 V	-0.008	±0.0006	+0.008	%FS
Gain Error Temperature Drift	Buffer disabled, REF = 5 V	0.000	±0.025	0.000	ppm/°C
Cam End Temperature Sint	Buffer enabled, REFIN = 5 V		±0.07		ppm/°C
Power Supply Sensitivity	VDD_5V = 5.4 V ± 0.1 V		±0.07		ppm
Tomor Supply Constantly	VDD 1.8V = 1.8 V ± 5%		±0.2		ppm
Low Frequency Noise ²	Bandwidth = 0.1 Hz to 10 Hz		1.8		μV p-p
AC ACCURACY	Dandwidth 6.1112 to 10112		1.0		PVPP
Dynamic Range			106		dB
Noise Spectral Density (NSD)			-166		dBFS/Hz
Total RMS Noise			17.7		μV rms
Signal to Noise Ratio (SNR)	f _{IN} = 1 kHz, -0.5 dBFS	103.3	105.7		dΒ
Spurious-Free Dynamic Range (SFDR)	f _{IN} = 1 kHz, -0.5 dBFS	100.0	127		dB
Total Harmonic Distortion (THD)	$f_{IN} = 1 \text{ kHz}, -0.5 \text{ dBFS}$		-127	- 115	dB
Signal-to-Noise-and-Distortion (SINAD) Ratio	f _{IN} = 1 kHz, -0.5 dBFS	103.3	105.7	110	dB
Oversampled Dynamic Range	Averaging = 2	100.0	109.7		dB
Oversampled Byffamic Nange	Averaging = 256		130		dB
	Averaging = 65536		152.7		dВ
SNR	VDD_5V = 5.0 V, f _{IN} = 1 kHz, -0.5 dBFS,		104.1		uD
SINK	REFIN = 4.096 V		104		dB
SFDR	VDD_5V = 5.0 V, f _{IN} = 1 kHz, -0.5 dBFS,		101		
5. 510	REFIN = 4.096 V		130		dB
THD	VDD_5V = 5.0 V, f _{IN} = 1 kHz, −0.5 dBFS,				
	REFIN = 4.096 V		-130		dB

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Table 1.

Table 1.					
Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
SINAD	$VDD_{5}V = 5.0 \text{ V}, f_{IN} = 1 \text{ kHz}, -0.5 \text{ dBFS},$				
	REFIN = 4.096 V		104		dB
SNR	$f_{IN} = 100 \text{ kHz}, -0.5 \text{ dBFS}$		105.6		dB
THD	$f_{IN} = 100 \text{ kHz}, -0.5 \text{ dBFS}$		-113		dB
SINAD	f _{IN} = 100 kHz, −0.5 dBFS		104.9		dB
-3 dB Input Bandwidth			74		MHz
Aperture Delay			0.7		ns
Aperture Jitter			1.4		ps rms
CHANNEL-TO-CHANNEL CROSSTALK	f _{IN} = 1 kHz, 1.3 kHz		-135		dB
INTERNAL REFERENCE BUFFER	External reference drives REFIN				
REFIN Voltage Range	5.3 V ≤ VDD_5V ≤ 5.5 V	4.95	5	5.05	V
	4.8 V ≤ VDD_5V ≤ 5.25 V		4.5		V
	4.75 V ≤ VDD_5V ≤ 5.25 V	4.046	4.096	4.146	V
REFIN Bias Current		-50	5	+50	nA
REFIN Input Capacitance			40		pF
Reference Buffer Offset Error	REFIN = 5 V, T _A = 25°C	-100	±25	+100	μV
	REFIN = 4.5 V, T _A = 25°C		±25		μV
	REFIN = 4.096 V, T _A = 25°C	-100	±25	+100	μV
Reference Buffer Offset Drift			±0.3		μV/°C
Power On Settling Time			3		ms
EXTERNALLY OVERDRIVEN REFERENCE	External reference drives REF (REFIN = 0				
	(V)				
REF Voltage Range	5.3 V ≤ VDD_5V ≤ 5.5 V	4.95	5	5.05	V
	4.8 V ≤ VDD_5V ≤ 5.25 V		4.5		V
	4.75 V ≤ VDD_5V ≤ 5.25 V	4.046	4.096	4.146	V
REF Current	f _S = 2 MSPS		1.8		μA
REF Input Capacitance			2		μF
DIGITAL INPUTS	1.14 V ≤ VIO ≤ 1.89 V				
Logic Levels					
Input Voltage Low (V _{IL})		-0.3		+0.35 × VIO	V
Input Voltage High (V _{IH})		0.65 × VIO		VIO + 0.3	V
Input Current Low (I _{IL})		-10		+10	μA
Input Current High (I _{IH})		-10		+10	μA
Input Pin Capacitance			2	. 10	pF
DIGITAL OUTPUTS	1.14 V ≤ VIO ≤ 1.89 V	Conversion			P'
Pipeline Delay	1.11 V = VIO = 1.00 V	results available			
r ipeline Belay		immediately after			
		completed			
		conversion			
Output Voltage Low (V _{OL})	I _{SINK} = 2 mA			0.25 × VIO	V
Output Voltage High (V _{OH})	I _{SOURCE} = 2 mA	0.75 × VIO			V
POWER SUPPLIES					
VDD_5V	REF = 5 V	5.3	5.4	5.5	V
	REF = 4.5 V	4.8	5	5.25	V
	REF = 4.096 V	4.75	5	5.25	V
VDD_1.8V		1.71	1.8	1.89	V
VIO ³		1.14		1.89	V
Standby Current					
VDD_5V			500		μA

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Table 1.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
VDD_1.8V			90		μA
VIO			<1		μΑ
Shutdown Current					
VDD_5V			5		μA
VDD_1.8V			5		μA
VIO			< 1		μA
Operating Current	Both channels active, 2 MSPS				
VDD_5V	VDD_5V = 5.4 V		2.7	3.2	mA
VDD_1.8V	VDD_1.8V = 1.8 V		8.2	11.2	mA
VIO	VIO = 1.8 V, 1-lane SDO		0.6		mA
Power Dissipation	Both channels active, 2 MSPS		30	39	mW
t _{RESET_DELAY}	After power-on, delay from VDD_5V and VDD_1.8V valid to RST assertion	3			ms
t _{RESET_PW}	RST pulse width	50			ns
TEMPERATURE RANGE					
Specified Performance	T _{MIN} to T _{MAX}	-40		+125	°C

¹ The acquisition phase is the time available for the input sampling capacitors to acquire a new input with the ADC running at a throughput rate of 2 MSPS.

TIMING SPECIFICATIONS

VDD_5V = 5.4 V, VDD_1.8V = 1.8 V, VIO = 1.8V, REFIN = 5 V, input common mode = 2.5 V, f_S = 2 MSPS, and all specifications T_{MIN} to T_{MAX} , unless otherwise noted. Typical values are at T_A = 25°C. See Figure 2 for the timing voltage levels. For VIO < 1.4 V, register bit IO2X must be set to 1.

Table 2. Digital Timing Interface

Parameter ¹	Symbol	Min	Тур	Max	Unit
Conversion Time—CNV Rising Edge to Data Available	t _{CONV}	264	282	300	ns
Acquisition Phase ²	t _{ACQ}	244	260		ns
Time Between Conversions	t _{CYC}	500			ns
CNV High Time	t _{CNVH}	10			ns
CNV Low Time	t _{CNVL}	20			ns
Internal Oscillator Frequency	fosc	75.1	80	84.7	MHz

¹ Timing specifications assume a 5 pF load capacitance on digital output pins. t_{CONV}, t_{CYC}, t_{SCK} and t_{SCKOUT} are production tested. All other timing specifications are guaranteed by characterization and design.

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² See the low frequency noise plot in Figure 24. 1/f noise is canceled internally by auto-zeroing. Noise spectral density is substantially uniform from dc to F_S/2.

³ When VIO < 1.4V, register bit IO2X must be set to 1. See Output Driver Register section.

² The acquisition phase is the time available for the input sampling capacitors to acquire a new input with the ADC running at a throughput rate of 2 MSPS.

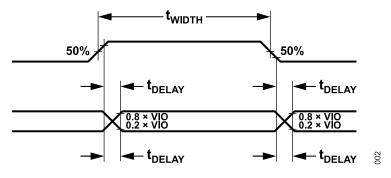


Figure 2. Voltage Levels for Timing

Table 3. Register Read/Write Timing

Parameter	Symbol	Min	Тур	Max	Unit
CS Pulse Width	t _{CSPW}	10			ns
SCK Period	t _{sck}				
VIO > 1.71V		11.6			ns
VIO > 1.14V		12.3			ns
SCK Low Time	t _{SCKL}	5.2			ns
SCK High Time	t _{scкн}	5.2			ns
SCK Falling Edge to Data Remains Valid	t _{HSDO}	2.1			ns
SCK Falling Edge to Data Valid Delay	t _{DSDO}				
VIO > 1.71V				9.4	ns
VIO > 1.14V				11.8	ns
CS Rising Edge to SDO High Impedance	t _{CSDIS}			9	ns
SDI Valid Setup Time to SCK Rising Edge	t _{SSDI}	1.5			ns
SDI Valid Hold Time from SCK Rising Edge	t _{HSDI}	1.5			ns
CS Falling Edge to first SCK Rising Edge	t _{CSSCK}				
VIO > 1.71V		11.6			ns
VIO > 1.14V		12.3			ns
Last SCK Edge to CS Rising Edge	t _{SCKCS}	5.2			ns

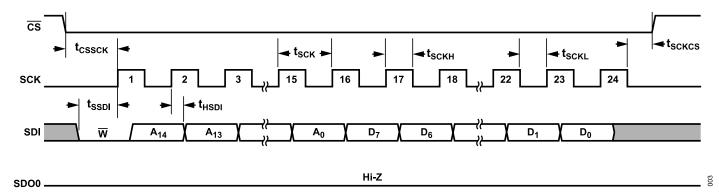


Figure 3. Register Configuration Mode Write Timing

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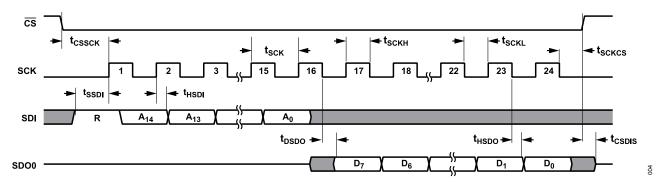


Figure 4. Register Configuration Mode Read Timing

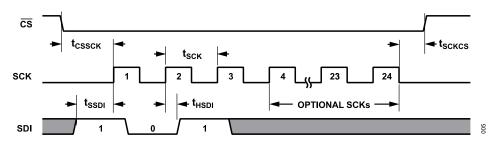


Figure 5. Register Configuration Mode Command Timing

Table 4. SPI Compatible Mode Timing

Parameter	Symbol	Min	Тур	Max	Unit
SCK Period	t _{SCK}				
VIO > 1.71 V		9.8			ns
VIO > 1.14 V		12.3			ns
SCK Low Time	t _{SCKL}				
VIO > 1.71 V		4.2			ns
VIO > 1.14 V		5.2			ns
SCK High Time	tsckh				
VIO > 1.71 V		4.2			ns
VIO > 1.14 V		5.2			ns
SCK Falling Edge to Data Remains Valid	t _{HSDO}	1.4			ns
SCK Falling Edge to Data Valid Delay	t _{DSDO}				
VIO > 1.71 V				5.6	ns
VIO > 1.14 V				8.1	ns
CS Falling Edge to SDO Valid	t _{CSEN}				ns
VIO > 1.71 V				6.8	ns
VIO > 1.14 V				9.3	ns
CS Falling Edge to first SCK Rising Edge	t _{CSSCK}				
VIO > 1.71 V		9.8			ns
VIO > 1.14 V		12.3			ns
Last SCK Edge to CS Rising Edge	t _{SCKCS}	4.2			ns
CS Rising Edge to SDO High Impedance	t _{CSDIS}			9	ns
CS falling edge to BUSY rising edge	tcsbusy		6		ns

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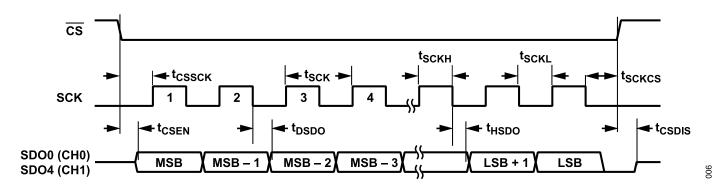


Figure 6. SPI Clocking Mode 1-Lane SDR Timing

Table 5. Echo Clock Mode Timing, SDR, 1-Lane

Parameter	Symbol	Min	Тур	Max	Unit
SCK Period	t _{SCK}				
VIO > 1.71 V		9.8			ns
VIO > 1.14 V		12.3			ns
SCK Low Time, SCK High Time	t _{SCKL} , t _{SCKH}				
VIO > 1.71 V		4.2			ns
VIO > 1.14 V		5.2			ns
SCK Rising Edge to Data/SCKOUT Remains Valid	t _{HSDO}	1.1			ns
SCK Rising Edge to Data/SCKOUT Valid Delay	t _{DSDO}				
VIO > 1.71 V				5.6	ns
VIO > 1.14 V				8.1	ns
CS Falling Edge to First SCK Rising Edge	tcssck				
VIO > 1.71 V		9.8			ns
VIO > 1.14 V		12.3			ns
Skew Between Data and SCKOUT	t _{SKEW}	-0.4	0	+0.4	ns
Last SCK Edge to CS Rising Edge	tsckcs	4.2			ns
CS Rising Edge to SDO High Impedance	t _{CSDIS}			9	ns

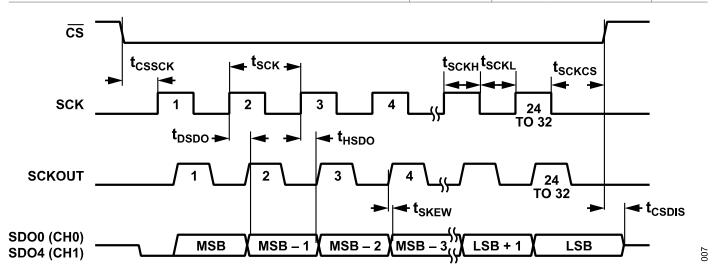


Figure 7. Echo Clock Mode Timing, SDR, 1-Lane

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Table 6. Echo Clock Mode Timing, DDR, 1-Lane

Parameter	Symbol	Min	Тур	Max	Unit
SCK Period	tscк	12.3			ns
SCK Low Time, SCK High Time	t _{SCKL} , t _{SCKH}	5.2			ns
SCK Edge to Data/SCKOUT Remains Valid	t _{HSDO}	1.1			ns
SCK Edge to Data/SCKOUT Valid Delay	t _{DSDO}				
VIO > 1.71 V				6.2	ns
VIO > 1.14 V				8.7	ns
CS Falling Edge to First SCK Rising Edge	tcssck	12.3			ns
Skew Between Data and SCKOUT	t _{SKEW}	-0.4	0	+0.4	ns
Last SCK Edge to CS Rising Edge	tsckcs	9			ns
CS Rising Edge to SDO High Impedance	t _{CSDIS}			9	ns

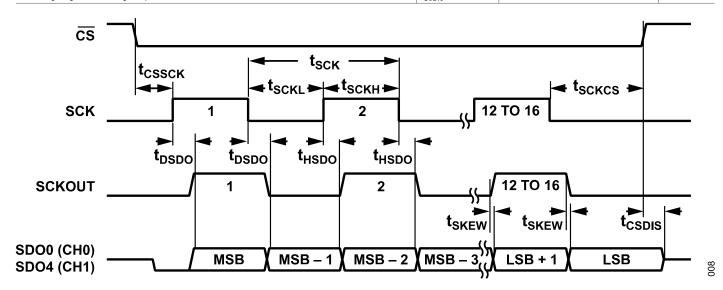


Figure 8. Echo Clock Mode Timing, DDR, 1-Lane

Table 7. Master Clock Mode Timing

Parameter	Symbol	Min	Тур	Max	Unit
SCK Period	t _{sckout}				
osc_div = No Divide		11.8	12.5	13.3	ns
osc_div = Divide by 2		23.6	25	26.6	ns
osc_div = Divide by 4		47.4	50	53.2	ns
SCK Low Time	tscкоuть	0.45 × t _{SCKOUT}		$0.55 \times t_{SCKOUT}$	ns
SCK High Time	tsскоитн	0.45 × t _{SCKOUT}		$0.55 \times t_{SCKOUT}$	ns
CS Falling Edge to First SCKOUT Rising Edge	t _{DSCKOUT}				
VIO > 1.71 V		10	13.6	19	ns
VIO > 1.14 V		10	15	21	ns
Skew Between Data and SCKOUT	t _{SKEW}	-0.4	0	+0.4	ns
Last SCKOUT Edge to CS Rising Edge	t _{SCKOUTCS}	5.2			ns
CS Rising Edge to SDO High Impedance	t _{CSDIS}			9	ns

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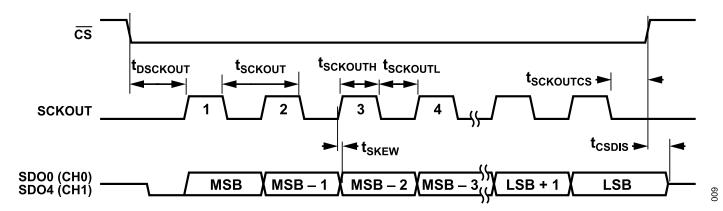


Figure 9. Master Clock Mode Timing, SDR, 1-Lane

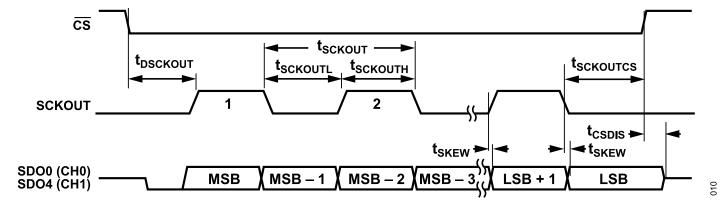


Figure 10. Master Clock Mode Timing, DDR, 1-Lane

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ABSOLUTE MAXIMUM RATINGS

Table 8.

Parameter	Rating
Analog Inputs	
IN1+, IN1-, IN0+, IN0-, REFIN to GND	-0.3V to VDD_5V +0.3V
Supply Voltage	
VDD_5V, REF to GND	-0.3V to +6.0 V
VDD_1.8V, VIO to GND	-0.3V to +2.1 V
Digital Inputs to GND	-0.3V to VIO+0.3V
CNV to GND	-0.3V to VIO+0.3V
Digital Outputs to GND	-0.3 V to VIO+0.3V
Storage Temperature Range	−55°C to +150°C
Operating Junction Temperature Range	-40°C to +125°C
Maximum Reflow (Package Body) Temperature	260°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

Table 9. Thermal Resistance

Package Type	θ_{JA}	θ_{JC}	Unit
BC-64-8	35	16	°C/W

ELECTROSTATIC DISCHARGE (ESD) RATINGS

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

Human body model (HBM) per ANSI/ESDA/JEDEC JS-001.

Field induced charged device model (FICDM) per ANSI/ESDA/JE-DEC JS-002.

ESD Ratings for AD4630-24

Table 10. AD4630-24, 64-Ball CSP_BGA

ESD Model	Withstand Threshold (kV)	Class
HBM	4	3A
FICDM	1.25	C3

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

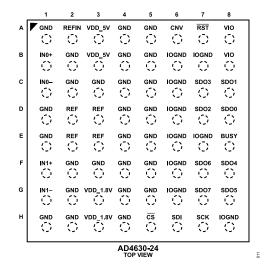


Figure 11. Pin Configuration

Table 11. Pin Function Descriptions

Pin No.	Mnemonic	Type ¹	Description
B1	IN0+	Al	Channel 0 Positive Analog Input.
C1	INO-	Al	Channel 0 Negative Analog Input.
F1	IN1+	Al	Channel 1 Positive Analog Input.
G1	IN1-	Al	Channel 1 Negative Analog Input.
A2	REFIN	Al	Buffered Reference Input. When using the internal reference buffer, drive REFIN with 4.096 V to 5 V (referred to GND). To disable the reference buffer, tie REFIN to GND and drive REF with 4.096 V to 5 V.
D2, D3, E2, E3	REF	Al	Optional un-buffered Reference Input. Drive REF with 4.096 V to 5 V (referred to GND). This pin has a 2 µF bypass capacitor inside the package. When using the internal reference buffer, do not connect REF.
D8	SDO0	DO	Chan 0 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
C8	SDO1	DO	Chan 0 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
D7	SDO2	DO	Chan 0 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
C7	SDO3	DO	Chan 0 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
F8	SDO4	DO	Chan 1 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
G8	SDO5	DO	Chan 1 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
F7	SDO6	DO	Chan 1 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
G7	SDO7	DO	Chan 1 Serial Data Output. The conversion result is output on this pin. It is synchronized to SCK.
H7	SCK	DI	Serial Data Clock Input. When the device is selected (\overline{CS} = low), the conversion result is shifted out by this clock.
H6	SDI	DI	Serial Data Input.
H5	CS	DI	Chip Select Input (Active Low).
A6	CNV	DI	Convert Input. A rising edge on this input powers up the part and initiates a new conversion. This signal should have low jitter in order to achieve the specified performance of the ADC. Logic levels are determined by VIO.
A7	RST	DI	Reset Input (active low). Asynchronous device reset.
E8	BUSY_SCKOUT	DO	BUSY Indicator in SPI clocking mode. Goes high at the start of a new conversion and returns low when the conversion has finished. Logic levels are determined by VIO. When SCKOUT is enabled this pin function is either an echo of the incoming SCK from the host controller or a clock sourced by the internal oscillator.
A3,B3	VDD_5V	Р	5 V Power Supply. The range of VDD_5V depends on the reference value: 5.3 V to 5.5 V for a 5 V reference, and 4.75 V to 5.25 V for a 4.096 V reference. This pin has a 1 μF bypass capacitor inside the package.
G3,H3	VDD_1.8V	Р	1.8V Power Supply. The range of VDD_1.8V is 1.71 V to 1.89V. This pin has a 1 µF bypass capacitor inside the package.

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PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Table 11. Pin Function Descriptions

Pin No.	Mnemonic	Type ¹	Description
A8, B8	VIO	Р	Input/Output Interface Digital Power. Nominally, this pin is at the same supply as the host interface (1.8 V, 1.5 V, or 1.2 V). This pin has a 0.2 μ F bypass capacitor inside the package. For VIO < 1.4 V register bit IO2X of the output driver register must be set to 1.
B6, B7, C6, D6, E6, E7, F6, G6, H8	IOGND	P	VIO Ground. Connect to the same ground plane as GND.
A1, D1, E1, H1, B2, C2, F2, G2, H2, C3, F3, A4, B4, C4, D4, E4, F4, G4, H4, A5, B5, C5, D5, E5, F5, G5	GND	P	Power Supply Ground.

¹ Al is analog input, P is power, DI is digital input, and DO is digital output.

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 $VDD_5V = 5.4 \text{ V}$, $VDD_1.8V = 1.8 \text{ V}$, VIO = 1.8V, REFIN = 5 V, input common mode = 2.5 V, $f_S = 2$ MSPS, and all specifications T_{MIN} to T_{MAX} , unless otherwise noted. Typical values are at $T_A = 25^{\circ}C$.

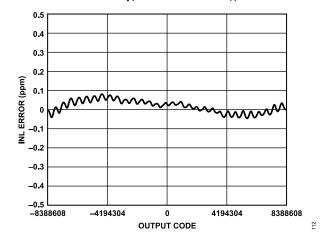


Figure 12. INL vs. Output Code, Differential Input

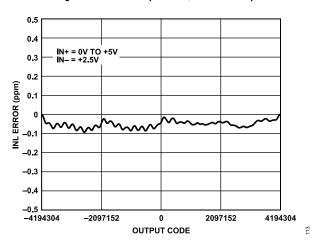


Figure 13. INL vs. Output Code, Single-Ended Input

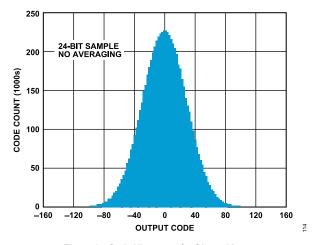


Figure 14. Code Histogram for Shorted Inputs

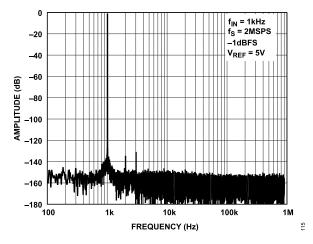


Figure 15. FFT, 2 MSPS, f_{IN} = 1 kHz, VREF = 5 V

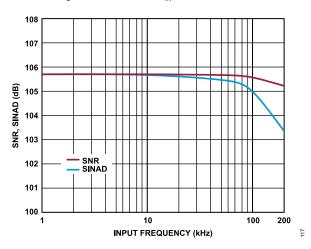


Figure 16. SNR and SINAD vs. Input Frequency

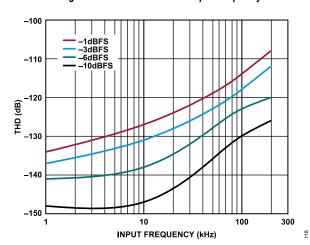


Figure 17. THD vs. Input Frequency and Amplitude

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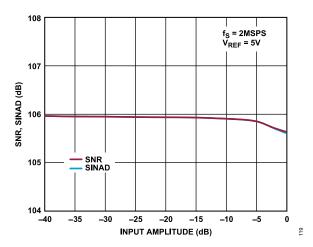


Figure 18. SNR and SINAD vs. Input Amplitude, $f_{IN} = 1 \text{ kHz}$

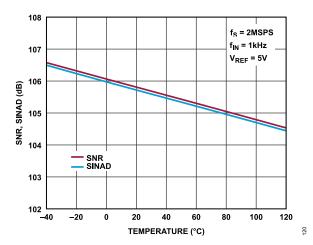


Figure 19. SNR and SINAD vs. Temperature, f_{IN} = 1 kHz

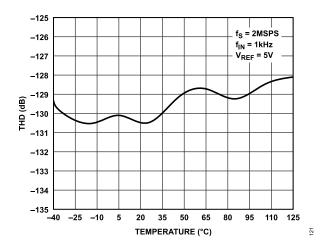


Figure 20. THD vs. Temperature, $f_{IN} = 1 \text{ kHz}$

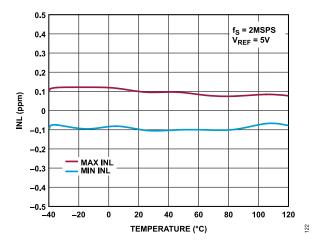


Figure 21. INL vs. Temperature

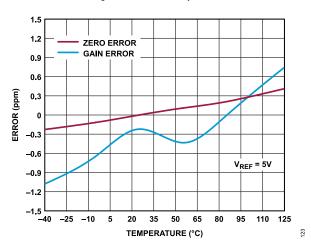


Figure 22. Zero Error, Gain Error vs. Temperature

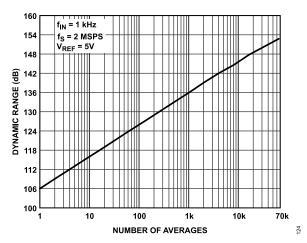


Figure 23. Dynamic Range vs. Averaging

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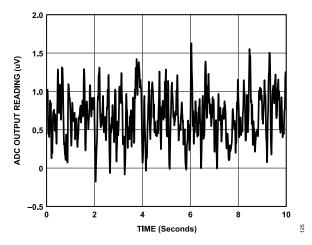


Figure 24. Low Frequency Noise (Output Data Rate = 19.5 SPS After Averaging Blocks of 2048 Samples)

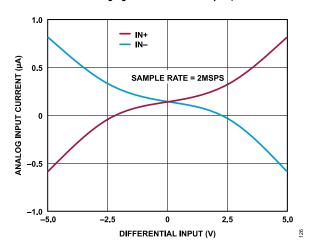


Figure 25. Analog Input Current vs. Differential Input

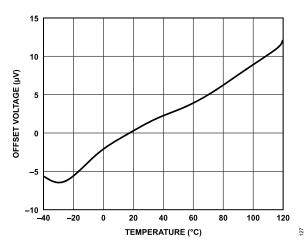


Figure 26. Reference Buffer Offset vs. Temperature

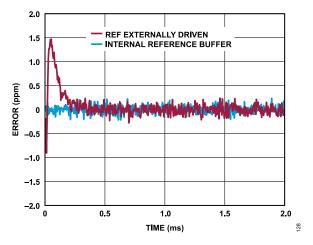


Figure 27. Error During Conversion Burst After Long Idle Time

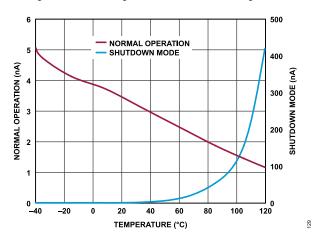


Figure 28. REFIN Current vs. Temperature

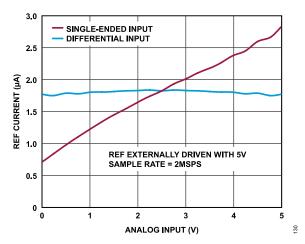


Figure 29. REF Current vs. Analog Input

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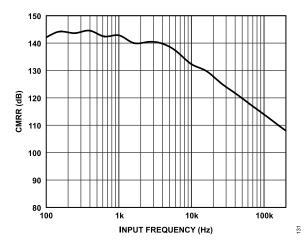


Figure 30. Common-Mode Rejection Ratio (CMRR) vs. Frequency

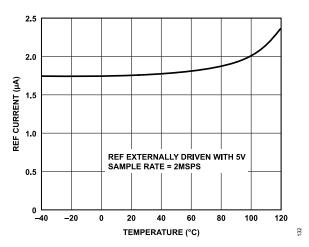


Figure 31. REF Current vs. Temperature

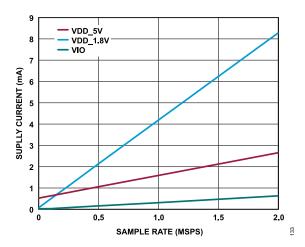


Figure 32. Supply Current vs. Sample Rate

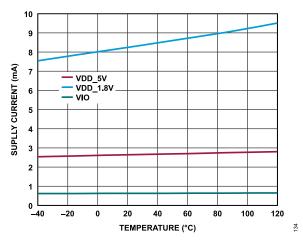


Figure 33. Supply Current vs. Temperature

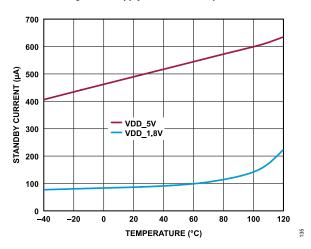


Figure 34. Supply Standby Current vs. Temperature

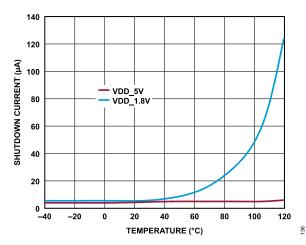


Figure 35. Supply Shutdown Current vs. Temperature

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TERMINOLOGY

INTEGRAL NONLINEARITY ERROR (INL)

INL is the deviation of each individual code from a line drawn from negative full scale through positive full scale. The point used as negative full scale occurs ½LSB before the first code transition. Positive full scale is defined as a level 1½LSB beyond the last code transition. The deviation is measured from the middle of each code to the true straight line (see Figure 37).

DIFFERENTIAL NONLINEARITY ERROR (DNL)

In an ideal ADC, code transitions are 1 LSB apart. DNL is the maximum deviation from this ideal value. It is often specified in terms of resolution for which no missing codes are guaranteed.

ZERO ERROR (ZE)

Zero error is the difference between the ideal midscale voltage, 0 V, and the actual voltage producing the midscale output code, 0 LSB.

GAIN ERROR (GE)

The first transition (from 100 ... 00 to 100 ... 01) occurs at a level ½LSB above nominal negative full scale. The last transition (from 011 ... 10 to 011 ... 11) occurs for an analog voltage 1½LSB below the nominal full scale. The gain error is the deviation of the difference between the actual level of the last transition and the actual level of the first transition from the difference between the ideal levels.

SPURIOUS-FREE DYNAMIC RANGE (SFDR)

SFDR is the difference, in decibels (dB), between the rms amplitude of a full-scale input signal and the peak spurious signal.

EFFECTIVE NUMBER OF BITS (ENOB)

ENOB is a measurement of the resolution with a sine wave input. It is related to SINAD as follows: ENOB = (SINADdB - 1.76)/6.02. ENOB is expressed in bits.

TOTAL HARMONIC DISTORTION (THD)

THD is the ratio of the rms sum of the first five harmonic components to the rms value of a full-scale input signal and is expressed in decibels.

DYNAMIC RANGE (DR)

Dynamic range is the rms voltage of a full-scale sine wave to the total rms voltage of the noise measured. The value for dynamic range is expressed in decibels. It is measured with a signal at -60 dBFS so that it includes all noise sources and DNL artifacts.

SIGNAL-TO-NOISE RATIO (SNR)

SNR is the ratio of the rms voltage of a full-scale sine wave to the rms sum of all other spectral components below the Nyquist frequency, excluding harmonics and dc. The value for SNR is expressed in decibels.

SIGNAL-TO-NOISE-AND-DISTORTION (SINAD) RATIO

SINAD is the ratio of the rms voltage of a full-scale sine wave to the rms sum of all other spectral components that are less than the Nyquist frequency, including harmonics but excluding dc. The value of SINAD is expressed in decibels.

APERTURE DELAY

Aperture delay is the measure of the acquisition performance and is the time between the rising edge of the CNV input and when the input signal is held for a conversion.

TRANSIENT RESPONSE

Transient response is the time required for the ADC to acquire a full-scale input step to ±1 LSB accuracy.

COMMON-MODE REJECTION RATIO (CMRR)

CMRR is the ratio of the power in the ADC output at the frequency, f, to the power of a 4.5 V p-p sine wave applied to the input common-mode voltage of frequency, f.

$$CMRR (dB) = 10 \times \log(\frac{P_{ADC_IN}}{P_{ADC_OUT}})$$

where:

 P_{ADC_IN} is the common-mode power at the frequency, f, applied to the inputs.

P_{ADC OUT} is the power at the frequency, f, in the ADC output.

POWER SUPPLY REJECTION RATIO (PSRR)

PSRR is the ratio of the power in the ADC output at the frequency, f, to the power of a 200 mV p-p sine wave applied to the ADC VDD supply of frequency, f.

$$PSRR (dB) = 10 \times \log(PVDD_IN/PADC\ OUT)$$

where:

 P_{VDD_IN} is the power at the frequency, f, at the VDD pin. P_{ADC_OUT} is the power at the frequency, f, in the ADC output.

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Figure 36 shows the basic functions of the AD4630-24.

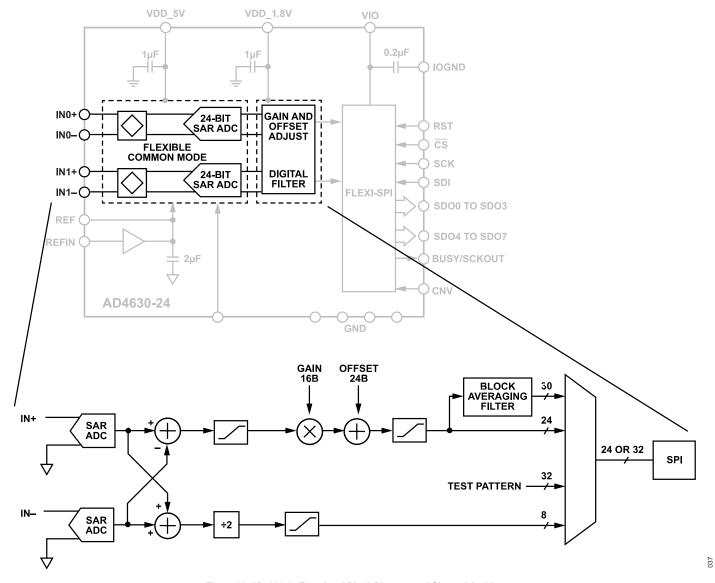


Figure 36. AD4630-24 Functional Block Diagram and Channel Architecture

OVERVIEW

The AD4630-24 is a low noise, low power, high speed, dual 24-bit successive approximation register (SAR) ADC. The AD4630-24 is capable of converting 2,000,000 samples per second (2 MSPS). It offers several analog and digital features to ease system design. The analog features include a wide common-mode range, which eases level shifting requirements as well as an extended fully differential input range of \pm (65/64) × VREF, easing the margin requirements on signal conditioning.

The AD4630-24 has an integrated reference buffer with an integrated decoupling capacitor to minimize the external components on board. The on-chip track-and-hold circuitry does not exhibit any pipeline delay or latency, making it ideal for control loops and high

speed applications. The digital features include offset correction, gain adjustment and averaging, which offload the host processor. The user can configure the part for one of several output code formats (see the Summary of Selectable Output Data Formats section).

The AD4630-24 uses a Flexi-SPI serial interface allowing the data to be accessed via multiple SPI lanes, which relaxes clocking requirements for the host SPI controller. An echo clock mode is also available to assist in data clocking, simplifying the use of isolated data interfaces. The AD4630-24 has a valid first conversion after exiting power-down mode. The AD4630-24 achieves ±0.9 ppm INL maximum, with no missing codes at 24 bits and 105.7 dB SNR at 2 MSPS. The AD4630-24 dissipates only 15 mW per channel at 2 MSPS.

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CONVERTER OPERATION

The AD4630-24 operates in two phases - acquisition phase and conversion phase. In the acquisition phase, the internal track-andhold circuitry is connected to each input pin (IN_{X+}, IN_{X-}) and samples the voltage on each pin independently. Issuing a rising edge pulse on the CNV pin initiates a conversion. The rising edge pulse on the CNV pin also asserts the BUSY signal to indicate a conversion in progress. At the end of conversion, the BUSY signal is de-asserted. The conversion result is a 24-bit code representing the input voltage difference and an 8-bit code representing the input common-mode voltage. Depending on the device configuration, this conversion result can be processed digitally and latched into the output register. The acquisition circuit on each input pin is also precharged to the previous sample voltage, which minimizes the kick-back charge to the input driver. The host processor retrieves the output code via the SDO pins that are internally connected to the output register.

TRANSFER FUNCTION

In the default configuration, the AD4630-24 digitizes the full-scale difference voltage of 2 × V_{REF} into 2^{24} levels, resulting in an LSB size of 0.596 μV with V_{REF} = 5 V. Note that 1 LSB at 24 bits is approximately 0.06 ppm. The ideal transfer function is shown in Figure 37. The differential output data is in twos complement format. Table 12 summarizes the mapping of input voltages to differential output codes.

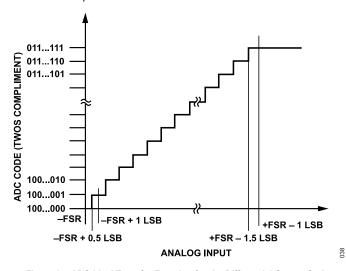


Figure 37. ADC Ideal Transfer Function for the Differential Output Codes (FSR Is Full-Scale Range)

Table 12. Input Voltage to Output Code Mapping

Description	Analog Input Voltage Difference	Digital Output Code (Twos Complement, Hex)
FSR - 1LSB	(8388607 × V _{REF})/(8388608)	0x7FFFFF
Midscale + 1LSB	V _{REF} /(8388608)	0x000001
Midscale	0 V	0x000000
Midscale - 1LSB	-V _{REF} /(8388608)	0xFFFFFF

Table 12. Input Voltage to Output Code Mapping

Description	Analog Input Voltage Difference	Digital Output Code (Twos Complement, Hex)
-FSR + 1LSB	-(8388607 × V _{REF})/(8388608)	0x800001
-FSR	- V _{REF}	0x800000

ANALOG FEATURES

AD4630-24 has a precharging circuit as a part of the internal trackand-hold circuitry, which charges the internal sampling capacitors to the previously sampled input voltage. This reduces the charge kickback, making it easier to drive than other conventional SAR ADCs. The reduced kickback, combined with a longer acquisition phase, means reduced settling requirements on the driving amplifier. This combination also allows the use of larger resistor values, which are beneficial for improving amplifier stability. Furthermore, the bandwidth of the RC filter is reduced, resulting in lower noise and/or power consumption of the signal chain.

The common-mode voltage is not restricted except by the absolute voltage range for each input (from –1/128 × V_{REF} to 129/128 × V_{REF}). The analog inputs can be modeled by the equivalent circuit shown in Figure 38. In the acquisition phase, each input sees approximately 58 pF (C_{IN}) from the sampling cap in series with 37 Ω on resistance (R_{ON}) of the sampling switch. During conversion phase, each input sees C_{PIN} , which is about 2 pF. Any signal that is common to both inputs is reduced by the common mode rejection of the ADC. During conversion, the analog inputs draw only a small leakage current.

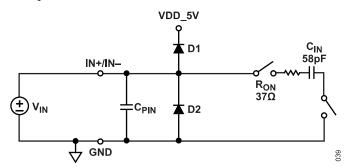


Figure 38. Equivalent Circuit for the AD4630-24 Differential Analog Input

Each input is sampled independently. The conversion results do not saturate assuming each of the inputs are within the specified full-scale input range. Note that digital domain saturation does occur if the digital offset and digital gain parameters are configured to map the conversion result to numeral values that exceed the full-scale digital range (-2^{23} to $+2^{23}$ – 1 for the 24-bit word). An input voltage difference up to $\pm (65/64) \times V_{REF}$ can be captured and converted without saturation by setting the digital gain parameter to a value < 1.

The slew rate at the analog input pins must be less than 400 V/ μ s during the acquisition phase and less than 30 V/ μ s at the sampling moment to ensure good performance. This can be ensured by

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choosing values for the external RC circuit such that the RC time-constant is more than 12.5 ns (R × C > 12.5e-9).

DIGITAL SAMPLE PROCESSING FEATURES

The AD4630-24 supports several digital/data processing features that can be applied to the signal samples, described in the following paragraphs. These features are enabled and disabled via the control registers of the AD4630-24. Figure 36 contains an ADC channel architecture block diagram illustrating the digital/data processing features available for each input channel.

Full-Scale Saturation

The conversion results saturate digitally (before any post-processing) when either or both inputs exceed the analog limits specified herein. After applying offset and gain scaling, the results are truncated to 24-bit representation (saturating at maximum 0x7FFFFF and minimum 0x800000). Care must be taken to avoid unintentional saturation, especially when applying digital offset and/or gain scaling. See the Digital Offset Adjust and Digital Gain sections for more details on the use of these features.

Common-Mode Output

When the host controller writes 0x1 or 0x2 to the OUT_DATA_MD bit field of the modes register (see the Modes Register section), an 8-bit code representing the input common-mode voltage is appended to the 16-bit or 24-bit code representing the input voltage difference. The LSB size of the 8-bit code is $V_{REF}/256$. The 8-bit code saturates at 0 and 255 when the common mode input voltage is 0 V and V_{REF} , respectively. The 8-bit code is not affected by digital offset and gain scaling, which is applied only to the code representing the input voltage difference.

Block Averaging

The AD4630-24 provides a block averaging filter (SINC1) with programmable block length 2^N, N = 0, 1, 2, 3, ..., 16. The filter is reset after processing each block of 2^N samples. The filter is enabled by writing 0x3 to the OUT DATA MD bit field of the modes register (see the Modes Register section) as well as a value $(1 \le N \le 16)$ to the AVG VAL bit field in the averaging mode register (see the Averaging Mode Register section). In this configuration the output sample word is 32-bits. The 30 most-significant bits represent the numerical value of the 24-bit codes averaged in blocks of 2^N samples. Scaling is such that the 24 MSBs of the 30-bit code are equal to the 24-bit codes when averaging blocks of constant values. The 31st bit (OR) is an over-range warning bit, which is high when one or more samples in the block are subject to saturation. The 32nd bit (SYNC)) is high once every 2^N conversion cycles to indicate when the average values are updated at the end of each block of samples. See Summary of Selectable Output Data Formats section for an illustration of the data format when the filter is enabled.

The effective data rate in averaging mode is $F_{CNV}/2^N$. The reset value of N in the AVG_VAL bit field is 0x00 (no averaging). Figure 53 shows an example timing diagram in averaging mode. Figure 39 shows the frequency response of the filter for a N = 1, 2, 3, 4, 5.

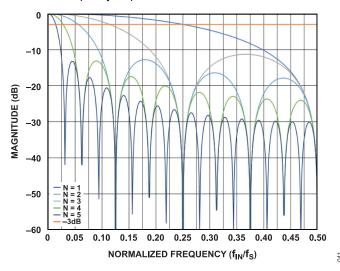


Figure 39. Frequency Response Examples for the Block Averaging Filter

Digital Offset Adjust

Each ADC channel can be independently programmed to add a 24-bit signed offset value to the sample data (see the Register Details section). When adding an offset to the samples, it is possible to cause the sample data to saturate numerically. The user must take this into account when using the offset feature. The default value is 0x000000. See the Channel 0 Offset Registers section or Channel 1 Offset Registers section in the AD4630-24 register map for more details.

Digital Gain

Each ADC channel can be independently programmed to apply a 16-bit unsigned digital gain (CHx_USER_GAIN) to the digital samples (see the Register Details section). The gain is applied to each sample based on the following equation:

 $Code_{OUT} = Code_{IN} \times (CHx_USER_GAIN/0x8000)$

where: $0x0000 \le CHx_USER_GAIN \le 0xFFFF$.

The effective gain range is 0 to 1.99997. Note that applying gain to the samples may cause numerical saturation. The default value is 0x8000 (gain = 1). To measure input voltage differences exceeding $(\pm V_{REF})$, set the gain below unity to avoid the numerical saturation of the 24-bit/16-bit/30-bit output differential codes. See the Channel 0 Gain Registers section or Channel 1 Gain Registers section in the AD4630-24 register map for more details.

Test Pattern

To facilitate functional testing and debugging of the SPI, the host controller can write a 32-bit test pattern to the AD4630-24 (see the

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Test Pattern Registers section). The value written to the test pattern registers applies to both ADC channels, and is output using the normal sample cycle timing on each channel. The 32-bit test pattern output mode is enabled by writing 0x4 to the OUT_DATA_MD bit field of the modes register (see the Modes Register section). The default value stored in the test pattern registers is 0x5A5A0F0F.

Summary of Selectable Output Data Formats

Figure 40 summarizes the output data formats that are available on the AD4630-24, which are selected in the modes register (see the Modes Register section). Note that the selected mode is applied to both channels. Note: OR and SYNC flags are each 1-bit.

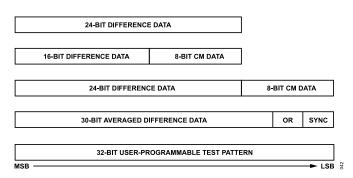


Figure 40. Summary of Selectable Output Sample Formats

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APPLICATIONS INFORMATION

TYPICAL APPLICATION DIAGRAMS

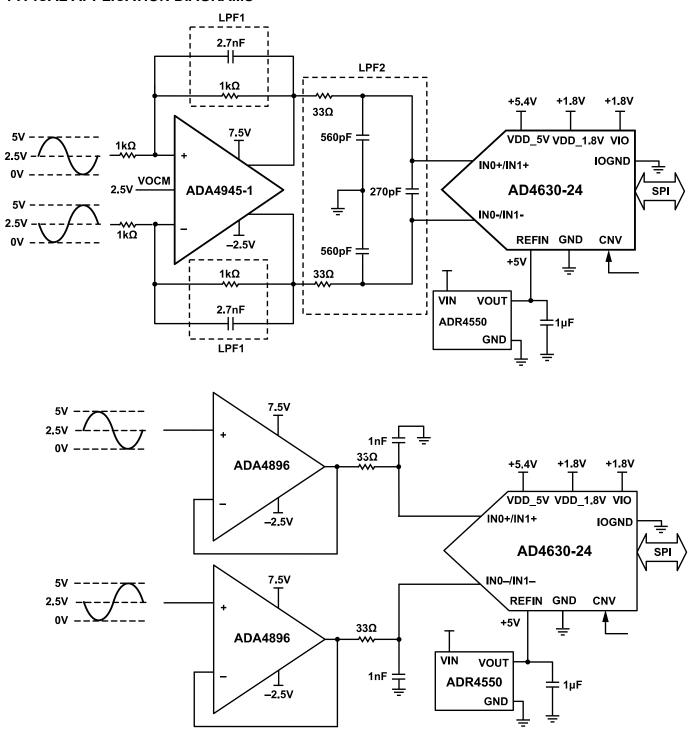


Figure 41. Typical Application Circuit Diagrams

ANALOG FRONT-END DESIGN

Driver Amplifier Choice

Figure 41 shows two examples for driving the AD4630-24. Either can be combined with an upstream stage that provides additional

signal conditioning. Both can accommodate single-ended or differential inputs. To take advantage of the excellent SNR and THD performance of the AD4630-24, it is important to choose a driver amplifier that has low noise and THD sufficient to meet the application requirements. In addition to the amplifiers shown in Figure 41, the LTC6227 is another driver option. Analog Devices offers several

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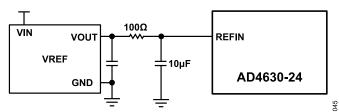
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companion driver amplifiers that can be found on the ADC drivers web page.

REFERENCE CIRCUITRY DESIGN

The AD4630-24 requires an external reference to define its input range. This reference must be 4.096 V to 5 V. A good choice for the reference is the ADR4550 or ADR4540. The ADC has several features that reduce the charge pulled from the reference, making the AD4630-24 much easier to use than other ADCs. For most applications, the reference can drive the REFIN pin, which has an internal precision buffer that isolates the reference from the ADC circuitry. The buffer has a high input impedance and small input current (5 nA typical) which allows multiple ADCs to share a common reference. An RC circuit between the reference and REFIN can be used to filter reference noise (see Figure 42). Suggested values are $100~\Omega < R < 1~k\Omega$, and $C >=10~\mu F$.



For the best possible gain error, the internal buffer can be disabled (REFIN = 0 V) and an external reference used to drive the REF pin. The current drawn by the REF pin is small (<2 μ A) and depends on the sample rate and output code (see Figure 29). An internal 2 μ F capacitor on the REF pin provides optimal reference bypassing and simplifies PCB design by reducing component count and layout sensitivity.

In applications where a burst of samples is taken after idling for long periods, as shown in Figure 43, I_{REF} quickly goes from approximately 0 μA to a maximum of 1.8 μA at 2 MSPS. This step in dc current draw triggers a transient response in the reference that must be considered since any deviation in the reference output voltage affects the accuracy of the output code. If the reference is driving the REFIN pin, the internal buffer is able to handle these transitions exceptionally well (see Figure 27). When the REF pin is being driven with no external buffer, and the transient response of the reference is important, the fast settling LTC6655LN-5 reference is recommended.



Figure 43. CNV Waveform Showing Burst Sampling

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APPLICATIONS INFORMATION

DEVICE RESET

The AD4630-24 provides two options for performing a device reset using the serial interface. A hardware reset is initiated by pulsing the voltage on the RST pin low. A software reset is initiated by setting both the SW_RESET and SW_RESETX bits in the Interface Configuration A register to 1 in the same write instruction (see the Interface Configuration A Register section).

Performing a hardware or software reset asserts the RESET_OC-CURRED bit in the digital diagnostics register (see the Digital Diagnostics Register section). The RESET_OCCURRED bit is cleared by writing it with a 1. RESET_OCCURRED can be used by the digital host to confirm the AD4630-24 has executed a device reset.

The AD4630-24 is designed to generate a power-on reset (POR) when VDD_5V and VDD_1.8V are first applied. A POR resets the state of the user configuration registers and asserts the RESET_OCCURRED bit. If VDD_5V or VDD_1.8V drops below its specified operating range, a POR occurs. It is recommended to perform a hardware or software reset after a POR.

Figure 44 shows the timing diagram for performing a device reset using the RST input. The minimum RST pulse width is 50 ns, represented by t_{RESETPW} in Figure 44 and Table 1. Reset must be performed no sooner than 3 ms after the power supplies are valid and stable (this delay is represented by t_{RESET_DELAY} in Figure 44 and Table 1).

After a hardware or software reset, no SPI commands or conversions can be started for 750 µs.

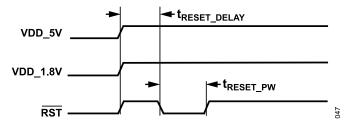


Figure 44. Power-On Reset (POR) Timing

POWER SUPPLIES

The AD4630-24 does not have any specific power supply sequencing requirements. Care must be taken to adhere to the maximum voltage relationships described in the Absolute Maximum Ratings section. The voltage range for the VDD_5V supply depends on the chosen reference voltage (see the Specifications table, Internal Reference Buffer, or Externally Overdriven Reference). Figure 45 shows the minimum and maximum values for VDD_5V with respect to REFIN and REF. VDD_5V voltage values above the maximum or below the minimum will result in either damage to the device or degraded performance.

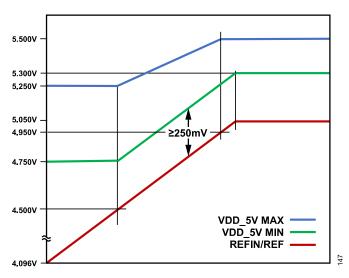


Figure 45. VDD 5V Minimum and Maximum Values for REFIN/REF

The AD4630-24 has a POR circuit that resets the AD4630-24 at initial power-up or whenever VDD_5V or VDD_1.8V drops below its specified operating range.

Note that the VDD_5V and the VDD_1.8V supplies have internal 1 μ F bypass capacitors inside the package, while VIO has an internal 0.2 μ F bypass capacitor. These internal capacitors reduce BOM count and solution size. If the bulk supply bypass capacitors are not close to the ADC, external capacitors can be added next to the ADC. The minimum rise time for all supplies is 100 μ s.

Power Consumption States

During a conversion, the power consumption rate of the AD4630-24 is at its highest. When the conversion is complete, it enters a standby state and much of the internal circuitry is powered down, and current consumption drops to less than 20% relative to the conversion state. To ensure full accuracy, some circuitry, including the reference buffer, remains powered on during the standby state.

The device can be placed into a lower power shutdown state during periods when the convert clock is idle by writing 0x3 to the OPERATING_MODES bit field of the device configuration register (see the Device Configuration Register section) . The default value of this bit field is [00] for normal operating mode. In the shutdown state, the current consumption typically drops to less than 10 μ A.

Shutdown Mode

When the user enters shutdown mode, the internal reference buffer is disabled and a 500 Ω switch connects REFIN to REF (unless REFIN is grounded and REF is externally driven). This keeps the 2 μ F capacitor on REF charged up to allow fast recovery when the user leaves shutdown mode. Because of this keep-alive switch, there is some charge injected to REFIN when the user enters shutdown mode (400 pC) and leaves shutdown mode (5 pC). When leaving shutdown mode, REF is accurate after 30 μ s.

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The AD4630-24 supports a multilane SPI serial digital interface for each channel, with a common bit-clock (SCK). The flexible VIO supply allows the AD4630-24 to communicate with any digital logic operating between 1.2 V and 1.8 V. However, for VIO levels below 1.4 V the IO2X bit in the output driver register must be set to 1 (see the Output Driver Register section). The serial output data is clocked out on up to 4 SDO lanes per channel (see Figure 46). An echo clock mode that is synchronous with the output data is available to ease timing requirements when using isolation on the digital interface. A master clock mode is also available and uses an internal oscillator to clock out the data bits. The following sections describe the operation of the AD4630-24 SPI.

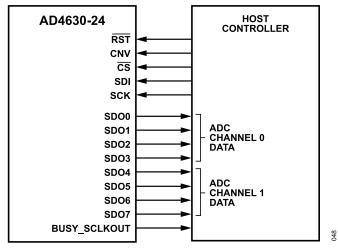


Figure 46. AD4630-24 Multilane SPI

SPI SIGNALS

The SPI is a multilane interface that is used to both configure the ADC as well as retrieve sampled data. It consists of the following signals:

- ▶ CS (input). Chip select. CS must be set LOW to initiate/enable a
 data transfer to/from the SDI/SDOx pins of the ADC. CS timing
 for reading sample data can be moderated by observing the
 state of the BUSY pin. For echo clock mode and master clock
 mode, CS timing must be controlled by the host processor, as
 the BUSY pin is used as the bit clock output for these clocking
 modes.
- SDI (input). Serial data input stream from the host controller to ADC. SDI is only used when writing data into one of the user registers of the AD4630-24.
- ➤ CNV (input). The CNV signal is sourced by the host controller and initiates a sample conversion. The frequency of CNV signal determines the sampling rate of AD4630-24. The maximum frequency of CNV clock is 2 MSPS.
- SCK (input). Serial data clock sourced by the host controller. The maximum supported SCK rate for output data transfer is 100 MHz. For register reads and writes, the maximum SCK rate is 86 MHz for VIO > 1.71 V, and 81 MHz for 1.14V ≤ VIO < 1.71 V.</p>

- ▶ SD00 through SD07 (outputs). Data lanes to the host controller. Lanes SD00 to SD03 are allocated to ADC channel 0, while lanes SD04 to SD07 are allocated to ADC channel 1. The number of data lanes configured for each channel can be either 1, 2, or 4 lanes (see the Table 14 section, output data modes). The number of data lanes is configured in the modes register. Note that the selected number of data lanes is applied to both ADC channels. The channels cannot be independently configured.
- BUSY_SCKOUT (output). The behavior of the BUSY_SCKOUT pin is dependent on selected clocking mode. Table 13 defines its behavior for each clocking mode.

Table 13. BUSY SCKOUT Pin Behavior vs. Clocking Mode

Clocking Mode	Behavior
SPI Clocking Mode	Valid BUSY signal for the ADC conversion status. BUSY goes high when a conversion is triggered by the CNV signal. BUSY goes low when the conversion is complete.
Echo Clock Mode	Bit clock. BUSY_SCKOUT is a delayed version of SCK input.
Master Clock Mode	Bit clock. BUSY_SCKOUT sources clock from the internal oscillator.

Register Access Mode

The AD4630-24 offers programmable user registers that are used to configure the device as outlined in the Registers section. By default, at power-up the device is in conversion mode. Therefore, to access the user registers, a special access command must be sent by the host controller over the SPI, as shown in Figure 5. When this register access command is sent over the SPI, the device enters the register configuration mode. To read back the values from one of the user registers listed in the Registers section, the host controller must send the pattern shown in Figure 4. To write to one of the user registers, the host controller must send the pattern shown in Figure 3. In either case (read/write), the host controller must always issue 24 clock pulses on SCK line and pull $\overline{\text{CS}}$ low for the entire transaction.

After writing to/reading from the appropriate user registers, the host controller must exit the register configuration mode by writing 0x01 to register address 0x0014 as detailed in the EXIT configuration mode register. An algorithm for register read/write access is as follows:

- **1.** Perform a read back from a dummy register address 0x3FFF, to enter the register configuration mode.
- **2.** Read back from or write to the desired user register addresses.
- Exit the register configuration mode by writing 0x01 to register address 0x0014. Exiting register configuration mode causes the register updates to take effect.

Stream Mode

The AD4630-24 also offers a way to perform bulk register read/ write transactions, while the AD4630-24 is in register configuration

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mode. To perform bulk read/write registers transactions, $\overline{\text{CS}}$ must be kept low and SCK pulses must be issued in multiples of 8 as each register is only one byte (8 bits) wide. In stream mode, only address decrementing is allowed, meaning that the user can read back from/write to the initial register address and register addresses that are directly below the initial register address. It is recommended that register accesses in stream mode be applied to register blocks with contiguous addresses. However, it is possible

to address registers that are not present in the register map. To do so, simply write all zeros to these registers, or, when reading back, simply discard the contents read from these registers, since it is random data. See the Registers section to see which register address is valid and continuous. For example, to read back a 24-bit offset value in one shot, the user must issue 24 SCK pulses staring from register address 0x0018. Figure 47 shows timing diagram for bulk read starting at a given address.

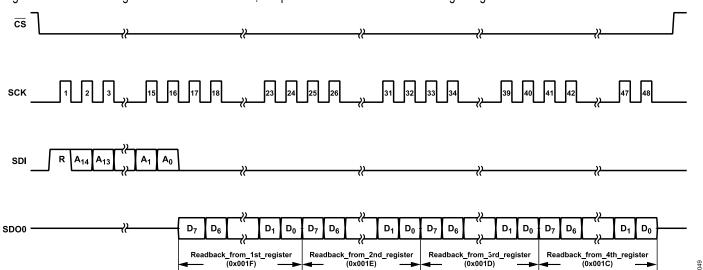


Figure 47. Stream Mode Bulk Register Read Back Operation

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SAMPLE CONVERSION TIMING AND DATA TRANSFER

A conversion is started on the rising edge of the CNV signal, as shown in Figure 48. Once the conversion is complete, \overline{CS} can be asserted, which causes the current conversion result to be loaded into the output shift register.

Referring to Figure 48 there are two optional data transfer zones for sample N. Zone 1 represents the use case where \overline{CS} is asserted immediately following the de-assertion of BUSY signal for the sample N conversion (in SPI conversion mode), or after 300 ns for echo and master clock modes. For Zone 1, the available time to read out sample N is given by:

Zone 1 data read window

$$= t_{CYC} - t_{CONV} - t_{OUIET\ CNV\ ADV}$$

For example, if F_{CNV} is 2 MSPS (t_{CYC} = 500 ns) and using the typical value of t_{CONV} (282 ns), the available window width is 198.4 ns (= 500 ns – 282 ns – 19.6 ns).

Zone 2 represents the case where assertion of $\overline{\text{CS}}$ to read sample N is delayed until after the conversion for sample N+1 has been initiated.

To prevent data corruption, a quiet zone must be observed before and after each rising edge of the CNV signal, as shown in Figure 48. The quiet zone immediately before the rising edge of CNV is labeled as $t_{\text{QUIET_CNV_ADV}}$, and is equal to 19.6 ns. The quiet zone immediately after the rising edge of CNV is labeled $t_{\text{QUIET_CNV_DE-LAY}}$, and is equal to 9.8 ns. Assuming that the $\overline{\text{CS}}$ is asserted immediately after the quiet zone around the rising edge of CNV, the amount of time available to clock out the data is:

Zone 2 data read window

$$= t_{CYC} - t_{QUIET_CNV_DELAY} - t_{QUIET_CNV_ADV}$$

For example, if F_{CNV} is 2 MSPS (t_{CYC} = 500 ns) and using the typical value of t_{CONV} (282 ns), the available window width is 470.6 ns (= 500 ns – 9.8 ns – 19.6 ns). The Zone 2 transfer window is longer than the Zone 1 window. This can enable the use of a slower SCK on the SPI and ease the timing requirements for the interface. When using Zone 2 for the data transfer, it is recommended to assert \overline{CS} immediately after the quiet zone. However, it must be asserted at least 25 ns before the falling edge of BUSY for sample N+1. If not, then sample N is overwritten with sample N+1.

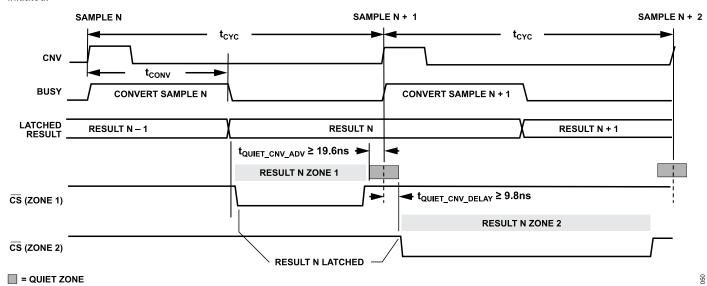


Figure 48. Example Timing for Data Transfer Zones

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CLOCKING MODES

This section covers the various clocking modes supported by the AD4630-24 SPI. These modes are available for 1-lane, 2-lane, 4-lane, and interleaved configurations. The clocking mode is configured in the modes register (see Table 16 for register descriptions). Note that the selected clocking mode applies to both ADC channels. They cannot be independently configured.

SPI Clocking Mode

SPI clocking mode is the default clocking mode of AD4630-24 and is equivalent to a host-sourced bit-clock (SCK), in which the host controller uses its own clock to latch the output data. The SPI

compatible clocking mode is enabled by writing 0x0 to the CLK_MD bit field of the modes register (see the Modes Register section). The interface connection is as shown in Figure 46. In this mode, the BUSY signal is valid, and indicates the completion of a conversion (high-to-low transition of BUSY). A simplified sample cycle is shown in Figure 49. When not in averaging mode, if the host controller does not use the BUSY signal to detect the completion of a conversion, and instead uses an internal timer to retrieve the data, it must wait at least 300 nsec after the rising edge of the CNV pulse before asserting $\overline{\text{CS}}$ low. When operating in block averaging mode, it must assert $\overline{\text{CS}}$ low no sooner than 300 nsec after the rising edge of the CNV pulse for the last sample in the block.

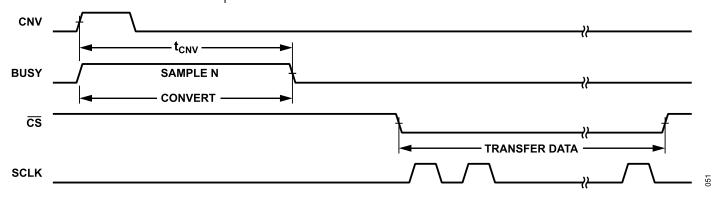


Figure 49. Typical Sample Cycle for SPI Clocking Mode

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Echo Clock Mode

Figure 50 shows the signal connections for the echo clock mode. The echo clock mode is enabled by writing 0x1 to the CLK MD bit field of the modes register (see the Modes Register section). In this mode, the BUSY-SCKOUT pin cannot be used to detect a conversion completion. The BUSY-SCKOUT pin becomes a bit-clock output, and is sourced by looping-through the host controller's SCK to the BUSY-SCKOUT pin (with some fixed delay, 5.4 ns to 7.9) ns, depending on VIO). To begin retrieving the conversion data in non-averaging mode, the host controller must assert \overline{CS} low no sooner than 300 nsec after the rising edge of the CNV pulse. When the ADC is configured for block averaging mode, the host controller must assert $\overline{\text{CS}}$ low no sooner than 300 nsec after the rising edge of the CNV pulse for the last sample in the block. Example timing diagrams are shown in the Data Clocking Requirements and Timing section. When echo clock mode is enabled, SCKOUT is aligned with SDOx transitions, making the data and clock timing insensitive to asymmetric propagation delays in the SDO and SCK paths.

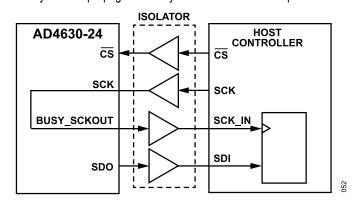


Figure 50. Echo Clock Mode Signal Path Diagram

Master Clock Mode

When enabled, master clock mode uses the internal oscillator as the bit clock source. The master clock mode is enabled by writing 0x2 to the CLK MD bit field of the modes register. The bit-clock frequency can be programmed in the OSC DIV bit field in the internal oscillator register, with available divisor values of 1, 2, or 4 (see the Internal Oscillator Register section). Figure 51 shows the signal connections for the master clock mode. In this mode, the BUSY-SCKOUT pin provides the bit clock output and cannot be used to detect a conversion completion. The AD4630-24 automatically calculates the number of clock pulses required to clock out the conversion data based on word size, number of active lanes, and choice of single data rate or dual data rate mode. The number of clock pulses can be read from the OSC LIMIT bit field of the internal oscillator register. The SCK from the host must not be active. When retrieving the conversion data in non-averaging mode, the host must not assert $\overline{\text{CS}}$ low sooner than 300 nsec after the rising edge of the CNV pulse. When the ADC is configured in averaging mode for 2^N averages, the host must not assert $\overline{\text{CS}}$ low

sooner than 300 nsec after the rising edge of CNV pulse for the last sample in the block.

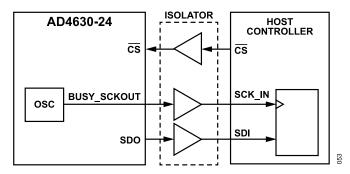


Figure 51. Master Clock Mode Signal Path Example

Single Data Rate

Single data rate clocking (SDR), in which one bit (per active lane) is clocked out during a single clock cycle, is supported for all output configurations and sample formats (see Table 14). The SDR clocking mode is enabled by default at power-up or can be enabled by writing 0 to the DDR_MD bit of the modes register (see the Modes Register section).

Dual Data Rate

Dual data rate (DDR) mode (two data bit transitions per clock cycle per active lane) is available only for master clock mode and echo clock mode.

Note that the selected data rate mode is applied to both ADC channels. The DDR clocking mode is enabled by writing 1 to the DDR_MD bit of the modes register (see the Modes Register section). The DDR mode uses half the number of SCK pulses to clock out conversion data in comparison to SDR mode.

1-Lane Output Data Clocking Mode

1-lane is the default output data clocking mode at power-up.
1-lane output data clocking mode is enabled by writing 0x0 to the LANE_MD bit of the modes register (see the Modes Register section). The active lane for ADC channel 0 is SDO0. The active lane for ADC channel 1 is SDO4. Example timing diagrams for 1-lane mode using SPI clocking mode, echo clock mode, and master clock mode are in the Data Clocking Requirements and Timing section.

2-Lane Output Data Clocking Mode

When 2-lane output data clocking mode is enabled, the sample word bits are split between two SDO lanes. Figure 54 shows how the bits are allocated between the lanes for 2-lane mode. The bit arrangement is the same for SPI, echo clock mode and master clock mode. 2-lane output data clocking mode is enabled by writing 0x1 to the LANE_MD bit of the modes register (see the Modes Register section). The host controller must recombine the data coming

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from the SDO lanes to reconstruct the original sample word. The number of SCK pulses required to clock out the conversion data is reduced by one-half with respect to the 1-lane mode. Table 14 lists the active SDO lanes for 2-lane mode. Example timing diagrams for 2-lane mode using SPI clocking mode, echo clock mode and master clock mode are in the Data Clocking Requirements and Timing section.

4-Lane Output Data Clocking Mode

When 4-lane output data clocking mode is enabled, the sample word bits are split between four SDO lanes. Figure 55 shows how the bits are allocated between the lanes for 4-lane mode. The bit arrangement is the same for SPI, echo clock mode and master clock mode. 4-lane output data clocking mode is enabled by writing 0x2 to the LANE_MD bit of the modes register (see the Modes Register section). The host controller must recombine the data coming from the SDO lanes to reconstruct the original sample word. The number of SCK pulses required to clock out the conversion data is reduced by one-fourth with respect to the 1-lane output data clocking. The active SDO lanes for 4-lane mode are shown in Table 14 Example timing diagrams for 4-lane mode using SPI clocking mode, echo clock mode and master clock mode are in the Data Clocking Requirements and Timing section.

Interleaved-Lane Output Data Clocking Mode

In the interleaved-lane output data clocking mode, Channel 0 and Channel 1 conversion data is interleaved on SDO0. The bit arrangement is shown in Figure 56. The bit arrangement is the same for SPI clocking mode, echo clock mode, and master clock mode. Interleaved-lane output data clocking mode is enabled by writing 0x3 to the LANE MD bit of the modes register (see the Modes Register section). The host controller must de-multiplex the data on SDO0 to reconstruct the original sample words. The number of SCK pulses required to clock out the conversion data is increased by 2× with respect to the 1-lane output data clocking. The data transfer can occur in either Zone 1 or Zone 2 (see Figure 48). Using the interleaved-lane output data clocking mode allows the host controller to use a single SDO lane to retrieve data from both ADC channels, reducing I/O requirements for the digital interface. Examples of interleaved-lane mode timing are shown in the Data Clocking Requirements and Timing section.

Data Output Modes Summary

Table 14 is a summary of the supported data output modes of the AD4630-24.

Table 14. AD4630-24 Supported Data Output Modes

Number of Lanes (per	Active SDO Lanes			Supported Data Clocking	
Channel)	Channel 0	Channel 1	Clock Mode	Mode	Output Sample Data Word Length
1	SDO0	SDO4	SPI	SDR only	24 or 32
			Echo	SDR and DDR	24 or 32
			Master	SDR and DDR	24 or 32
2	SD00, SD01	SDO4, SDO5	SPI	SDR only	24 or 32
			Echo	SDR and DDR	24 or 32
			Master	SDR and DDR	24 or 32
4	SD00, SD01, SD02, SD03	SDO4, SDO5, SDO6, SDO7	SPI	SDR only	24 or 32
			Echo	SDR and DDR	24 or 32
		Master	SDR and DDR	24 or 32	
Interleaved	SDO0		SPI	SDR only	48 or 64
				SDR and DDR	48 or 64
			Master	SDR and DDR	48 or 64

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DATA CLOCKING REQUIREMENTS AND TIMING

Basic and Averaging Conversion Cycles

Figure 52 illustrates the basic conversion cycle for a single sample. This cycle applies to SPI clocking mode. When using echo clock mode and master clock modes, the BUSY function is disabled and the bit clock is sourced on the BUSY pin. The data transfer must meet the requirements described in the Sample Conversion Timing and Data Transfer section.

Table 15 contains the minimum and maximum values for the conversion timing parameters, which apply to all clocking modes.

Table 15. Conversion Cycle Timing Parameters

Parameter	Min	Max
t _{CNV_HI}	10 ns	No specific maximum
t _{CNV_LO}	20 ns	No specific maximum
t _{CNV}	264 ns	300 ns

The duration of the data transfer period is dependent on the sample resolution, number of active lanes, SCK frequency, and data clocking mode (SDR or DDR). The nominal value of the transfer duration is given by:

Data transfer duration

$$=t_{TRANS}=rac{N_{BITS}}{M_{LANES}} imesrac{1}{f_{SCK}} imesrac{1}{K}$$
 seconds

where:

N_{BITS} = number of bits to clock out

M_{LANES} = number of lanes used to clock out the data (1, or 2, or 4)

f_{SCK} = SCK clock frequency, in Hz.

K = 1 (SDR only, DDR not available for SPI mode clocking)

For a given f_{SCK}, number of data lanes, and sample word size, and SDR/DDR mode, the minimum sample period when using Zone 1 for the data transfer is as follows:

Minimum Zone 1 sample period:

$$t_{CYC} \ge \left(\frac{N_{BITS}}{M_{LANES} \times f_{SCK} \times K}\right) + t_{CONV} + t_{QUIET_CNV_ADV}$$

The minimum sample period when using Zone 2 for data transfer is as follows:

$$t_{CYC} \ge \left(\frac{N_{BITS}}{M_{LANES} \times f_{SCK} \times K}\right) + t_{QUIET_CNV_DELAY} + t_{QUIET_CNV_ADV}$$

Figure 53 shows a typical conversion cycle when the averaging mode is active and SPI clocking mode is being used. The BUSY signal is asserted for a number of CNV clock periods that is equal to the configured number of samples to be averaged. The averaged sample is then available when the BUSY signal is de-asserted. Like non-averaged mode, if the configured clocking mode is either echo clock or master clock, then the BUSY signal is replaced by the output bit clock (SCKOUT). The host controller must manage the timing for asserting $\overline{\text{CS}}$.

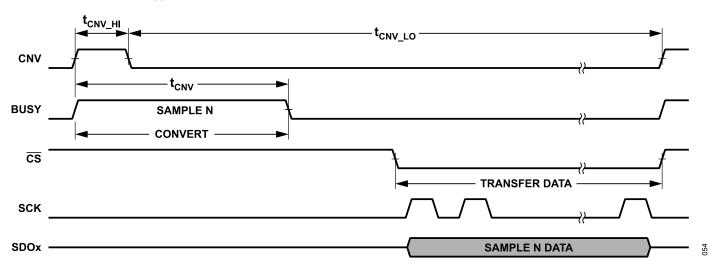


Figure 52. Basic Single Sample Conversion Cycle

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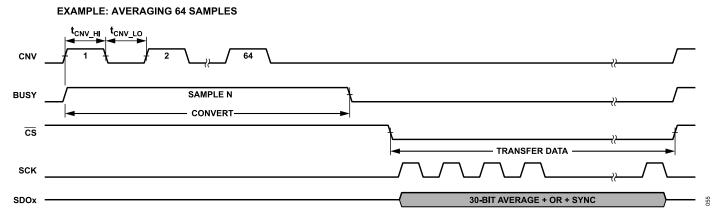


Figure 53. Example Conversion Cycle for Averaging Mode

SPI Clocking Mode Timing Diagrams

1-Lane, SDR Mode

Figure 6 shows a conversion cycle for single lane data output, SDR mode (1-bit per clock cycle). This cycle timing is the same for both ADC channels.

2-Lane, SDR Mode

Figure 54 shows a conversion cycle for 2-lane data output, using SDR clocking mode. Figure 54 shows the timing for Channel 0, but also applies to Channel 1. See the 2-Lane Output Data Clocking Mode section for a detailed explanation.

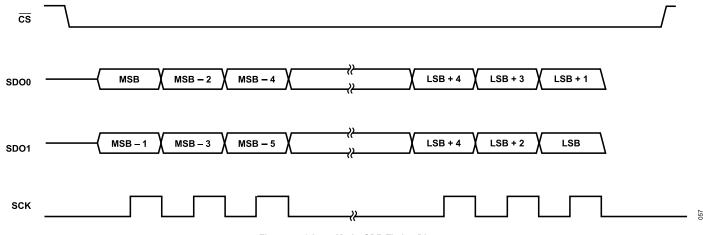
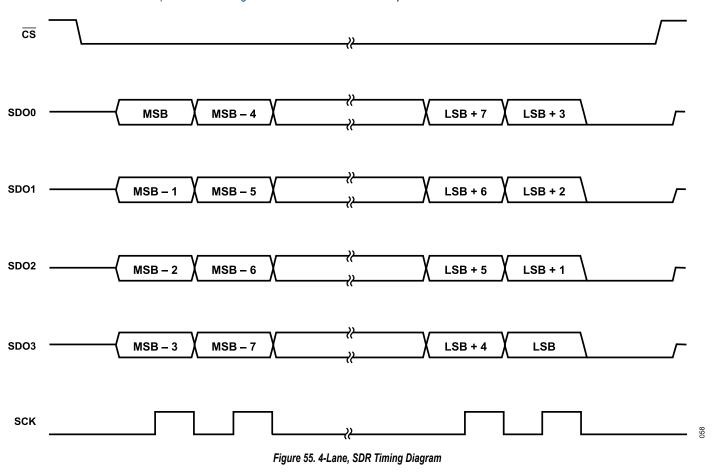


Figure 54. 2-Lane Mode, SDR Timing Diagram

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4-Lane, SDR Mode

Figure 55 shows a conversion cycle for 4-lane data output, SDR clocking mode. Figure 55 shows the timing for Channel 0, but also applies to Channel 1. See the 4-Lane Output Data Clocking Mode section for a detailed explanation.



Interleaved Mode Timing, SDR Mode

Figure 56 shows a conversion cycle for interleaved data output, SDR clocking mode. See the Interleaved-Lane Output Data Clocking Mode section for a detailed explanation.

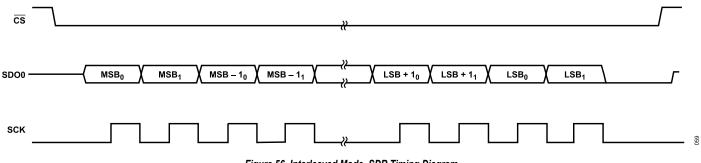


Figure 56. Interleaved Mode, SDR Timing Diagram

Echo Clock Timing Diagrams

1-Lane, SDR Mode, Echo Clock Mode

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Figure 7 shows the timing relationships for SDR mode (1-bit per SCK period) in 1-lane echo clock mode. The timing relationships between the signals apply to both 24-bit and 32-bit sample word formats.

SCKOUT is a delayed version of the incoming SCK. The delay (t_{DSDO}) has a maximum value of 5.6 ns (at VIO > 1.71 V). Changes in SDOx logic states are aligned to the rising edges of SCKOUT. The clock and data edge alignments are the same for 1-lane, 2-lane, and 4-lane output data modes.

1-Lane, DDR Mode, Echo Clock Mode

Figure 8 shows the timing relationships for DDR mode (2-bit transitions per SCKOUT period) in 1-lane mode echo clock mode. The timing relationships between the signals apply to both 24-bit and 32-bit sample word formats.

Similar to SDR mode, SCKOUT is a delayed version of the incoming SCK. Changes in SDOx logic states are aligned to both rising and falling edges of SCKOUT.

Master Clock Mode Timing

1-Lane, Master Clock Mode, SDR

Figure 9 shows the timing relationships for master clock mode when using SDR mode and 1-lane mode. Similar to echo clock mode, the clock rising edges are aligned to the data bit transitions. The frequency of SCKOUT signal is controlled by the OSC_DIV value programmed in the internal oscillator register (see the Internal Oscillator Register section).

1-Lane, Master Clock Mode, DDR

Figure 10 shows the timing relationships for master clock mode when using DDR. Similar to echo clock mode, the rising and falling clock edges are aligned to the data bit transitions. The frequency of SCKOUT signal is controlled by the OSC_DIV value programmed in the internal oscillator register (see the Internal Oscillator Register section).

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LAYOUT GUIDELINES

The following layout guidelines are recommended to achieve maximum performance out of the AD4630-24:

- The AD4630-24 contains internal 1 μF bypass capacitors for VDD_5V and VDD_1.8V, while VIO contains an internal 0.2 μF capacitor, so no external bypass capacitors are required, saving board space, BOM count, and reducing layout sensitivity.
- ▶ It is recommended to have all the analog signals to flow-in from the left side of the AD4630-24 and all the digital signal to flow in-out from the right side of AD4630-24 as this helps isolate analog signals from digital signals.
- ▶ Use a solid ground plane under the AD4630-24 and connect all the analog ground (GND) pins and digital ground (IOGND) pins

- to the shared ground plane in order to avoid formation of ground loops.
- ▶ Traces routed to either the REFIN pin or REF pins must be isolated/shielded from other signals. Avoid routing signals beneath the reference trace (REFIN or REF). The REF pins are connected to an internal 2 μF capacitor, eliminating the need to place a decoupling capacitor on the output of the external reference buffer. If a noise reduction filter is placed between the output of the reference (or buffer) and the chosen reference input, it must be placed as close as possible to the AD4630-24.

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REGISTERS

The AD4630-24 has programmable user registers which are used to configure the device. These registers can be accessed while the AD4630-24 is in register configuration mode. Table 16 contains the complete list of the AD4630-24 user registers and list of the bit fields in the registers. The Register Details section contains details

about the functions of each of the fields. The access mode specifies whether the register is comprised only of read-only bits (R) or a mix of read-only and read/write bits (R/W). Read-only bits cannot be overwritten by a SPI write transaction, while read/write bits can.

Table 16. AD4630-24 Register Summary

Reg	Name	Bits	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset	R/W
0x00	INTERFACE_CONFIG _A	[7:0]	SW_RESET [7]	RESERVED [6]	ADDR_ASC ENSION [5]	SDO_EN ABLE [4]	RESER	VED [3:1	1]	SW_RES ETX [0]	0x10	R/W
0x01	INTERFACE_CONFIG _B	[7:0]	SINGLE_INST [7]	STALLING [6]	RESERV	ED [5:4]	SHORT_INST RUCTION [3]	R	RESERVE	D [2:0]	0x00	R/W
0x02	DEVICE_CONFIG	[7:0]			RESERVED [7:2]				ATING_MO ES [1:0]	0x00	R/W
0x03	CHIP_TYPE	[7:0]		RESERVED [7:4] CHIP_TYPE [3:0]				0x07	R			
0x04	PRODUCT_ID_L	[7:0]			PRO	DUCT_ID[7:	0]				0x00	R
0x05	PRODUCT_ID_H	[7:0]			PRO	DUCT_ID[15	:8]				0x20	R
0x06	CHIP_GRADE	[7:0]		GR	ADE [7:3]			DEVICE	_REVISI	ON [2:0]	0x00	R
0x0A	SCRATCH_PAD	[7:0]		SCRATCH_VALUE [7:0]				0x00	R/W			
0x0B	SPI REVISION	[7:0]	SPI TYP	SPI_TYPE [7:6] VERSION [5:0]				0x81	R			
0x0C	VENDOR_L	[7:0]	_					0x56	R			
0x0D	VENDOR_H	[7:0]						0x04	R			
0x0E	STREAM_MODE	[7:0]			LOO	P_COUNT [7	:01				0x00	R/W
0x11	INTERFACE_STATUS _A	[7:0]	RESER	VED [7:5]	CLOCH OUNT_ R [4	C_C _ER	RESERVED [3:0]				0x00	R/W
0x14	EXIT_CFG_MD	[7:0]	RESERVED [7:1] EXIT_CO NFIG_MD [0]				0x00	R/W				
0x15	AVG	[7:0]	AVG_SYNC [7]	RESER	VED [6:5]		AVG \	/AL [4:0]			0x00	R/W
0x16	OFFSET_CH0_LB	[7:0]		CH0_USER_OFFSET[7:0]					0x00	R/W		
0x17	OFFSET_CH0_MB	[7:0]			CH0 US	ER_OFFSET	[15:8]				0x00	R/W
0x18	OFFSET_CH0_HB	[7:0]			CH0 US	ER_OFFSET	[23:16]				0x00	R/W
0x19	OFFSET_CH1_LB	[7:0]			CH1 US	SER_OFFSE	T[7:0]				0x00	R/W
0x1A	OFFSET_CH1_MB	[7:0]				ER_OFFSET					0x00	R/W
0x1B	OFFSET_CH1_HB	[7:0]				ER_OFFSET					0x00	R/W
0x1C	GAIN_CH0_LB	[7:0]				 USER_GAIN	<u> </u>				0x00	R/W
0x1D	GAIN_CH0_HB	[7:0]				JSER_GAIN[=				0x80	R/W
0x1E	GAIN_CH1_LB	[7:0]				JSER_GAIN					0x00	R/W
0x1F	GAIN_CH1_HB	[7:0]				JSER_GAIN[-				0x80	R/W
0x20	MODES	[7:0]	LANE_MI	D [7:6]	CLK M		DDR MD [3]	OU	T DATA	MD [2:0]	0x00	R/W
0x21	OSCILLATOR	[7:0]	_	OSC_LIM					 DIV [1:0]		0x00	R/W
0x22	10	[7:0]			RESERVE	ED [7:1]				IO2X [0]	0x00	R/W
0x23	TEST_PAT_BYTE0	[7:0]				t_, _DATA_PAT[7:01			- 1-1	0x0F	R/W
0x24	TEST_PAT_BYTE1	[7:0]				 _Data_pat[1					0x0F	R/W
0x25	TEST PAT BYTE2	[7:0]				DATA_PAT[2					0x5A	R/W
0x26	TEST_PAT_BYTE3	[7:0]				DATA_PAT[3					0x5A	R/W
0x34	DIG_DIAG	[7:0]	POWERUP COMPLETED [7]	RESET_OC CURRED [6]	1201_		ERVED [5:1]			FUSE_CR C_EN [0]		R/W
0x35	DIG_ERR	[7:0]		, ,,	RESERVI	ED [7:1]				FUSE_CR C_ERR [0]	0x00	R/W

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INTERFACE CONFIGURATION A REGISTER

Address: 0x00, Reset: 0x10, Name: INTERFACE_CONFIG_A

Interface configuration settings.

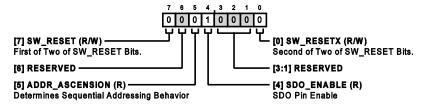


Table 17. Bit Descriptions for INTERFACE CONFIG A

Bits	Bit Name	Description	Reset	Acces
7	SW_RESET	One of two of SW_RESET bits. This bit appears in two locations in this register. Both locations must be written at the same time to trigger a software reset of the part. All registers except for this register are reset to their default values.	0x0	R/W
6	RESERVED	Reserved.	0x0	R
5	ADDR_ASCENSION	Determines sequential addressing behavior.	0x0	R
		0: Address accessed is decremented by one for each data byte when streaming.1: Not a valid option.		
4	SDO_ENABLE	SDO Pin Enable.	0x1	R
[3:1]	RESERVED	Reserved.	0x0	R
0	SW_RESETX	Two of two of SW_RESET bits. This bit appears in two locations in this register. Both locations must be written at the same time to trigger a software reset of the part. All registers except for this register are reset to their default values.	0x0	R/W

INTERFACE CONFIGURATION B REGISTER

Address: 0x01, Reset: 0x00, Name: INTERFACE_CONFIG_B

Additional interface configuration settings.

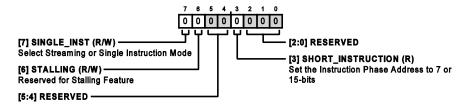


Table 18. Bit Descriptions for INTERFACE_CONFIG_B

Bits	Bit Name	Description	Reset	Access
7	SINGLE_INST	Select streaming or single instruction mode.	0x0	R/W
		0: Streaming mode is enabled. The address decrements as successive data bytes are received.		
		1: Single instruction mode is enabled.		
6	STALLING	Reserved for Stalling Feature.	0x0	R/W
5:4]	RESERVED	Reserved.	0x0	R
	SHORT_INSTRUCTION	Set the instruction phase address to 7 bits or 15 bits.	0x0	R
		0: 15-bit addressing.		
		1: 7-bit addressing.		
2:0]	RESERVED	Reserved.	0x0	R

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DEVICE CONFIGURATION REGISTER

Address: 0x02, Reset: 0x00, Name: DEVICE_CONFIG

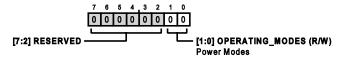


Table 19. Bit Descriptions for DEVICE CONFIG

Bits	Bit Name	Description	Reset	Access
[7:2]	RESERVED	Reserved.	0x0	R
[1:0]	OPERATING_MODES	Power Modes	0x0	R/W
		00: Normal Operating Mode.		
		11: Shutdown Mode.		

CHIP TYPE REGISTER

Address: 0x03, Reset: 0x07, Name: CHIP_TYPE

The chip type is used to identify the family of Analog Devices products a given device belongs to. Use the chip type with the product ID to uniquely identify a given product.

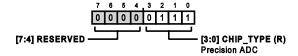


Table 20. Bit Descriptions for CHIP TYPE

Bits	Bit Name	Description	Reset	Access
[7:4]	RESERVED	Reserved.	0x0	R
[3:0]	CHIP_TYPE	Precision ADC.	0x7	R

PRODUCT ID LOW REGISTER

Address: 0x04, Reset: 0x00, Name: PRODUCT_ID_L

Low byte of the product ID.

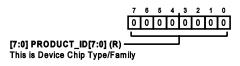


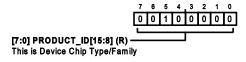
Table 21. Bit Descriptions for PRODUCT_ID_L

Bits	Bit Name	Description	Reset	Access
[7:0]	PRODUCT_ID[7:0]	This is the device chip type/family. Use the product ID with the chip type to identify a product.	0x0	R

PRODUCT ID HIGH REGISTER

Address: 0x05, Reset: 0x20, Name: PRODUCT_ID_H

High byte of the product ID.



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Table 22. Bit Descriptions for PRODUCT_ID_H

Bits	Bit Name	Description	Reset	Access
[7:0]	PRODUCT_ID[15:8]	This is the device chip type/family. Use the product ID with the chip type to identify a product.	0x20	R

CHIP GRADE REGISTER

Address: 0x06, Reset: 0x00, Name: CHIP_GRADE

Identifies product variations and device revisions.

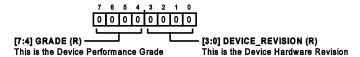


Table 23. Bit Descriptions for CHIP_GRADE

Bits	Bit Name	Description	Reset	Access
[7:4]	GRADE	This is the device performance grade.	0x0	R
[3:0]	DEVICE_REVISION	This is the device hardware revision.	0x1	R

SCRATCH PAD REGISTER

Address: 0x0A, Reset: 0x00, Name: SCRATCH_PAD

This register can be used to test writes and reads.

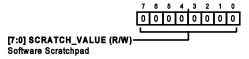


Table 24. Bit Descriptions for SCRATCH_PAD

Bits	Bit Name	Description	Reset	Access
[7:0]	SCRATCH_VALUE	Software Scratchpad. Software can write to and read from this location without any device side effects.	0x0	R/W

SPI REVISION REGISTER

Address: 0x0B, Reset: 0x81, Name: SPI_REVISION

Indicates the SPI revision.

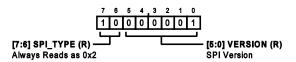


Table 25. Bit Descriptions for SPI REVISION

Bits	Bit Name	Description	Reset	Access
[7:6]	SPI_TYPE	Always reads as 0x2.	0x2	R
[5:0]	VERSION	SPI Version.	0x1	R

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VENDOR ID LOW REGISTER

Address: 0x0C, Reset: 0x56, Name: VENDOR_L

Low byte of the vendor ID.

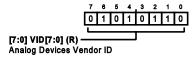


Table 26. Bit Descriptions for VENDOR L

Bits	Bit Name	Description	Reset	Access
[7:0]	VID[7:0]	Analog Devices Vendor ID.	0x56	R

VENDOR ID HIGH REGISTER

Address: 0x0D, Reset: 0x04, Name: VENDOR_H

High byte of the vendor ID.

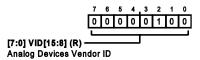


Table 27. Bit Descriptions for VENDOR_H

Bits	Bit Name	Description	Reset	Access
[7:0]	VID[15:8]	Analog Devices Vendor ID.	0x4	R

STREAM MODE REGISTER

Address: 0x0E, Reset: 0x00, Name: STREAM_MODE

Defines the length of the loop when streaming data.

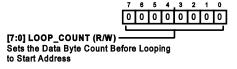


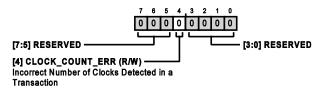
Table 28. Bit Descriptions for STREAM_MODE

Bits	Bit Name	Description	Reset	Access
[7:0]	LOOP_COUNT	Not enabled in the AD4630-24.	0x0	R/W

INTERFACE STATUS A REGISTER

Address: 0x11, Reset: 0x00, Name: INTERFACE_STATUS_A

Status bits are set to 1 to indicate an active condition. The status bits can be cleared by writing a 1 to the corresponding bit location.



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Table 29. Bit Descriptions for INTERFACE STATUS A

Bits	Bit Name	Description	Reset	Access
[7:5]	RESERVED	Reserved.	0x0	R
4	CLOCK_COUNT_ERR	0 = No error.	0x0	R/W1C
		1 = Incorrect Number of Clocks Detected in a Transaction. Write 1 to clear.		
[3:0]	RESERVED	Reserved.	0x0	R

EXIT CONFIGURATION MODE REGISTER

Address: 0x14, Reset: 0x00, Name: EXIT_CFG_MD

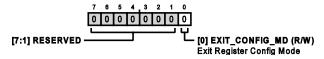


Table 30. Bit Descriptions for EXIT_CFG_MD

Bits	Bit Name	Description	Reset	Access
[7:1]	RESERVED	Reserved.	0x0	R
0	EXIT_CONFIG_MD	Exit Register Config Mode. Write 1 to exit register config mode. Self clearing upon \overline{CS} = 1.	0x0	R/W

AVERAGING MODE REGISTER

Address: 0x15, Reset: 0x00, Name: AVG

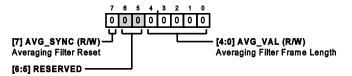
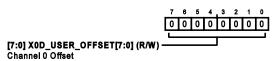


Table 31. Bit Descriptions for AVG

Bits	Bit Name	Description	Reset	Access
7	AVG_SYNC	Averaging Filter Reset. 1 = reset, self clearing.	0x0	R/W
[6:5]	RESERVED	Reserved.	0x0	R
[4:0]	AVG_VAL	Averaging Filter Block Length, 2 ^N .	0x0	
		0x00 = no averaging.		
		$0x01 = 2^1$ samples.		
		$0x02 = 2^2$ samples.		
		$0x03 = 2^3$ samples.		
		$0x04 = 2^4$ samples.		
		$0x05 = 2^5$ samples.		
		$0x0F = 2^{15}$ samples.		
		$0x10 = 2^{16}$ samples.		
		0x11 through 0x1F = invalid.		

CHANNEL 0 OFFSET REGISTERS

Address: 0x16, Reset: 0x00, Name: OFFSET_CH0_LB



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Table 32. Bit Descriptions for OFFSET CH0 LB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH0_USER_OFFSET[7:0]	LS Byte of the 24-Bit Channel 0 Offset. Twos complement (signed). 1 LSB = $\frac{V_{REF}}{2^{23}}/GAIN$. See the Channel 0 Gain Registers section for a description of the GAIN parameter.	0x0	R/W

Address: 0x17, Reset: 0x00, Name: OFFSET_CH0_MB



Table 33. Bit Descriptions for OFFSET_CH0_MB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH0_USER_OFFSET[15:8]	Mid-Byte for the 24-Bit Channel 0 Offset. Twos complement (signed). 1 LSB = $\frac{V_{REF}}{2^{23}}/GAIN$. See the Channel 0 Gain Registers section for a description of the GAIN parameter.	0x0	R/W

Address: 0x18, Reset: 0x00, Name: OFFSET_CH0_HB



Table 34. Bit Descriptions for OFFSET_CH0_HB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH0_USER_OFFSET[23:16]	MS Byte of the 24-Bit Channel 0 Offset. Twos complement (signed). 1 LSB = $\frac{V_{REF}}{2^{23}}/GAIN$. See the Channel 0 Gain Registers section for a description of the GAIN parameter.	0x0	R/W

CHANNEL 1 OFFSET REGISTERS

Address: 0x19, Reset: 0x00, Name: OFFSET_CH1_LB

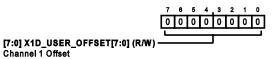


Table 35. Bit Descriptions for OFFSET_CH1_LB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH1_USER_OFFSET[7:0]	LS Byte of the 24-Bit Channel 1 Offset. Twos complement (signed). 1 LSB = $\frac{V_{REF}}{2^{23}}/GAIN$. See the Channel 1 Gain Registers section for a description of the GAIN parameter value.	0x0	R/W

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Address: 0x1A, Reset: 0x00, Name: OFFSET_CH1_MB



Table 36. Bit Descriptions for OFFSET CH1 MB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH1_USER_OFFSET[15:8]	Mid-Byte of the 24-Bit Channel 1 Offset. Twos complement (signed). 1 LSB = $\frac{V_{REF}}{2^{23}}/GAIN$. See the Channel 1 Gain Registers section for a description of the GAIN parameter value.	0x0	R/W

Address: 0x1B, Reset: 0x00, Name: OFFSET_CH1_HB



Table 37. Bit Descriptions for OFFSET_CH1_HB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH1_USER_OFFSET[23:16]	MS Byte of the 24-Bit Channel 1 Offset. Twos complement (signed). 1 LSB = $\frac{V_{REF}}{2^{23}}/GAIN$. See the Channel 1 Gain Registers section for a description of the GAIN parameter value.	0x0	R/W

CHANNEL 0 GAIN REGISTERS

Address: 0x1C, Reset: 0x00, Name: GAIN_CH0_LB

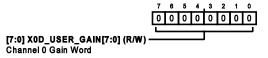


Table 38. Bit Descriptions for GAIN_CH0_LB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH0_USER_GAIN[7:0]	LS Byte of Channel 0 16-Bit Gain Word (Unsigned). Multiplier output = input × Gain Word/0x8000. Maximum effective gain = 0xFFFF/0x8000 = 1.99997.	0x00	R/W

Address: 0x1D, Reset: 0x80, Name: GAIN_CH0_HB

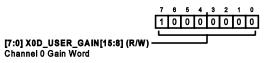


Table 39. Bit Descriptions for GAIN_CH0_HB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH0_USER_GAIN[15:8]	MS Byte of Channel 0 16-Bit Gain Word (Unsigned). Multiplier output = input × Gain Word/0x8000. Maximum effective gain = 0xFFFF/0x8000 = 1.99997.	0x80	R/W

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CHANNEL 1 GAIN REGISTERS

Address: 0x1E, Reset: 0x00, Name: GAIN_CH1_LB

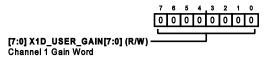


Table 40. Bit Descriptions for GAIN_CH1_LB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH1_USER_GAIN[7:0]	LS Byte of the Channel 1, 16-Bit Gain Word (Unsigned). Multiplier output = input × Gain Word/0x8000. Maximum effective gain = 0xFFFF/0x8000 = 1.99997.	0x00	R/W

Address: 0x1F, Reset: 0x80, Name: GAIN_CH1_HB

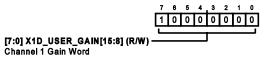


Table 41. Bit Descriptions for GAIN CH1 HB

Bits	Bit Name	Description	Reset	Access
[7:0]	CH1_USER_GAIN[15:8]	MS Byte of the Channel 1, 16-Bit Gain Word (Unsigned). Multiplier output = input × Gain Word/0x8000. Maximum effective gain = 0xFFFF/0x8000 = 1.99997.	0x80	R/W

MODES REGISTER

Address: 0x20, Reset: 0x00, Name: MODES

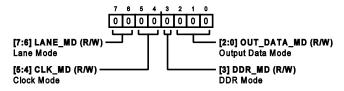


Table 42. Bit Descriptions for MODES

Bits	Bit Name	Description	Reset	Access
[7:6]	LANE_MD	Lane Mode Select.	0x0	R/W
		00 = one lane per channel.		
		01 = two lanes per channel.		
		10 = four lanes per channel.		
		11 = Channel 0 and Channel 1 interleaved on SDO0.		
[5:4]	CLK_MD	Clock Mode Select.	0x0	R/W
J. 4]		00 = SPI clocking mode.		
		01 = echo clock mode.		
		10 = master clock mode.		
		11 = invalid setting.		
3	DDR_MD	DDR Mode Enable/Disable.	0x0	R/W
		0 = SDR.		
		1 = DDR (only valid for echo clock and master clock modes).		
		· · · · · · · · · · · · · · · · · · ·		_

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Table 42. Bit Descriptions for MODES

Bits	Bit Name	Description	Reset	Access
[2:0]	OUT_DATA_MD	Output Data Mode Select.	0x0	R/W
		000 = 24-bit differential data.		
		001 = 16-bit differential data + 8-bit common mode data.		
		010 = 24-bit differential data + 8-bit common mode data.		
		011 = 30-bit averaged differential data + OR-bit + SYNC-bit.		
		100 = 32-bit test data pattern (see the Test Pattern Registers section).		

INTERNAL OSCILLATOR REGISTER

Address: 0x21, Reset: 0x00, Name: OSCILLATOR

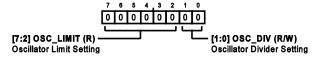


Table 43. Bit Descriptions for OSCILLATOR

Bits	Bit Name	Description	Reset	Access
[7:2]	OSC_LIMIT	Oscillator Limit Setting. Oscillator is limited to this number of clock pulses plus one. Automatically calculated by the AD4630-24 based on the data word size, number of active SDO lanes, and data rate mode (SDR or DDR).	0x0	R
[1:0]	OSC_DIV	Oscillator Frequency Divider Setting.	0x0	R/W
		00 = no divide (divide by 1).		
		01 = divide by 2.		
		10 = divide by 4.		
		11 = invalid setting.		

OUTPUT DRIVER REGISTER

Address: 0x22, Reset: 0x00, Name: IO

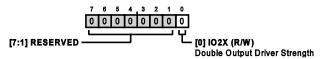
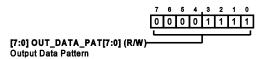


Table 44. Bit Descriptions for IO

Bits	Bit Name	Description	Reset	Access
[7:1]	RESERVED	Reserved.	0x0	R
0	IO2X	Double Output Driver Strength.	0x0	R/W
		1 = double output driver strength.		
		0 = normal output driver strength.		

TEST PATTERN REGISTERS

Address: 0x23, Reset: 0x0F, Name: TEST_PAT_BYTE0



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Table 45. Bit Descriptions for TEST PAT BYTE0

Bits	Bit Name	Description	Reset	Access
[7:0]	TEST_DATA_PAT[7:0]	LS Byte of the 32-Bit Test Pattern Word. Applied to both channels when OUT_DATA_MD = 4 (see the Modes Register section).	0xF	R/W

Address: 0x24, Reset: 0x0F, Name: TEST_PAT_BYTE1

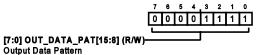


Table 46. Bit Descriptions for TEST_PAT_BYTE1

Bits	Bit Name	Description	Reset	Access
[7:0]	TEST_DATA_PAT[15:8]	LS+1 Byte of the 32-Bit Test Pattern. Applied to both channels when OUT_DATA_MD = 4 (see the Modes Register section).	0xF	R/W

Address: 0x25, Reset: 0x5A, Name: TEST_PAT_BYTE2

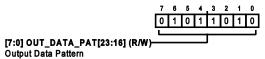


Table 47. Bit Descriptions for TEST PATBYTE2

Bits	Bit Name	Description	Reset	Access
[7:0]	TEST_DATA_PAT[23:16]	LS+2 Byte of the 32-Bit Test Pattern. Applied to both channels when OUT_DATA_MD = 4 (see the Modes Register section).	0x5A	R/W

Address: 0x26, Reset: 0x5A, Name: TEST_PAT_BYTE3

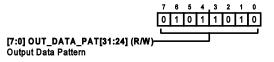


Table 48. Bit Descriptions for TEST_PAT_BYTE3

Bits	Bit Name	Description	Reset	Access
[7:0]	TEST_DATA_PAT[31:24]	MS Byte of the 32-Bit Test Pattern. Applied to both channels when OUT_DATA_MD = 4 (see the Modes Register section).	0x5A	R/W

DIGITAL DIAGNOSTICS REGISTER

Address: 0x34, Reset: 0x40, Name: DIG_DIAG

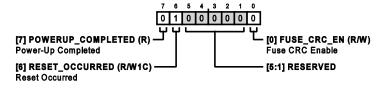


Table 49. Bit Descriptions for DIG_DIAG

Bits	Bit Name	Description	Reset	Access
7	POWERUP_COMPLETED	1 = Power-Up Completed. Self clearing.	0x0	R

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Table 49. Bit Descriptions for DIG_DIAG

Bits	Bit Name	Description	Reset	Access
6	RESET_OCCURRED	Reset Occurred. This bit is set to 1 upon a reset event. Write 1 to clear (useful for detecting brownouts).	0x1	R/W1C
[5:1]	RESERVED	Reserved.	0x0	R
0	FUSE_CRC_EN	Fuse CRC Enable. Write a 1 to force recheck of CRC.	0x0	R/W

DIGITAL ERRORS REGISTER

Address: 0x35, Reset: 0x00, Name: DIG_ERR

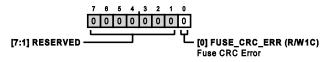
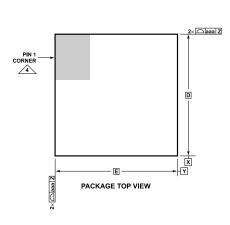


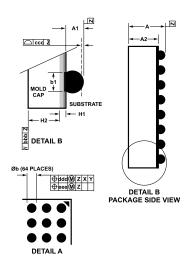
Table 50. Bit Descriptions for DIG_ERR

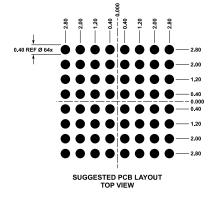
Bits	Bit Name	Description	Reset	Access
[7:1]	RESERVED	Reserved.	0x0	R
0	FUSE_CRC_ERR	Fuse CRC Error. This bit is set to 1 upon a fuse CRC error. Write 1 to clear.	0x0	R/W1C

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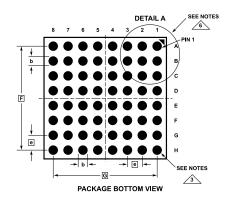
OUTLINE DIMENSIONS







DIMENSIONS							
SYMBOL	MIN	NOM	MAX	NOTES			
Α	1.52	1.72	1.92				
A1	0.30	0.32	0.50	BALL HT			
A2	1.22	1.32	1.42				
b	0.45	0.50	0.55	BALL DIMENSIO			
b1	0.37	0.40	0.43	PAD DIMENSION			
D	7.00						
Е	7.00						
е	0.80						
F	5.60						
G	5.60						
H1		0.32	REF	SUBSTRATE TH			
H2		1.00	REF	MOLD CAP HT			
aaa			0.15				
bbb			0.20				
ccc			0.20				
ddd			0.15				
eee			0.08				
	TOTAL	NUMBER	OF BALL	_S: 64			



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994

2. ALL DIMENSIONS ARE IN MILLIMETERS

3 BALL DESIGNATION PER JEP95

DETAILS OF PIN #1 IDENTIFIER ARE OPTIONAL,
BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
THE PIN #1 IDENTIFIER MAY BE EITHER A MOLD OR
MARKED FEATURE

5. PRIMARY DATUM -Z- IS SEATING PLANE

PACKAGE ROW AND COLUMN LABELING MAY VARY AMONG µModule PRODUCTS. REVIEW EACH PACKAGE LAYOUT CAREFULLY

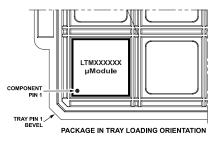


Figure 57. 64-Ball Chip Scale Package Ball Grid Array [CSP_BGA] (BC-64-8) Dimensions shown in millimeters